

IUT WEBINARS

Quantum Information Technology

Episode #5: Joint Symposium on Quantum Photonic Integrated Circuits

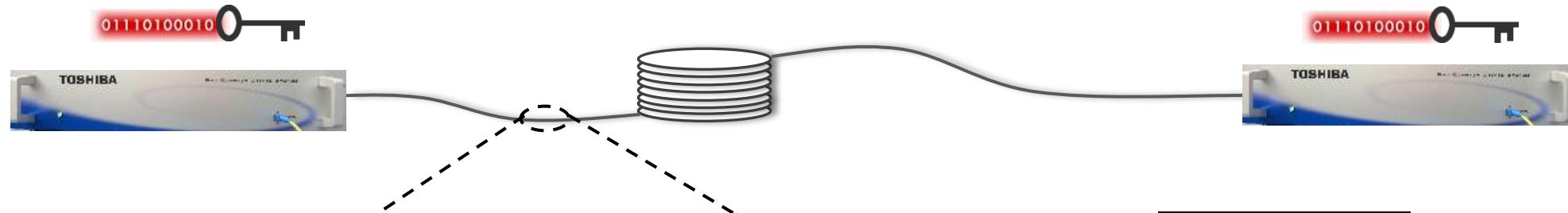
A Photonic Integrated Quantum Secure Communication System

T.K. Paraiso, T. Roger, D.G. Marangon, I. de Marco, M. Sanzaro,
R.I. Woodward, J.F. Dynes, Z. Yuan, A.J. Shields

TOSHIBA

Toshiba Europe Limited
Cambridge Research Laboratory
Quantum Information group
2021.11.02

Quantum Cryptography



Quantum Key Distribution

- each bit encoded on a single photon

Conventional public-key cryptography (RSA, ECDH)

› Long-term confidentiality threatened by *harvest and decrypt* attacks

› Encrypted data are easily collected and stored

› Decrypt later when more powerful computers are available

GGCTCGGTTCCAAAGATCAAGGGAG
TGTTAGCTCTTGGTCCTCGATCGTT
TGTTATGGCAGCACTGCATAATTCTC
TGACTGGTGAGTACTCAACCAAAGTC
CTTGCCCCGGCGTCAATACGGGATAAT
ATCATGGAAAAAGTTCTCGGGGCG
GGTTGATGTAACCCACTGTGCAACC
TTTCTGGGTGAGCAAAAACAGGAAG



Bio-Medical

Corporate



Financial



Critical Infrastructure

Quantum key distribution

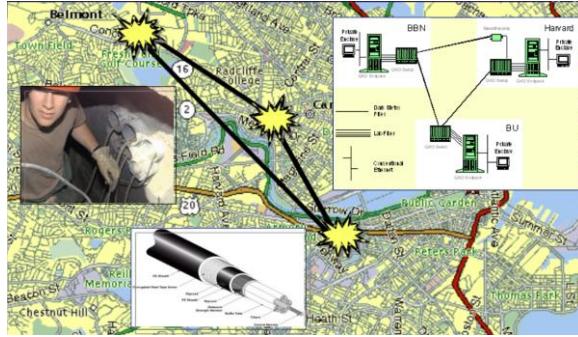
› Detect eavesdropping on fibre as measurable noise in the quantum channel



› Distribute secret digital keys that are secure from future advances in cryptanalysis and computing

Enabling the wide-scale deployment of quantum cryptography

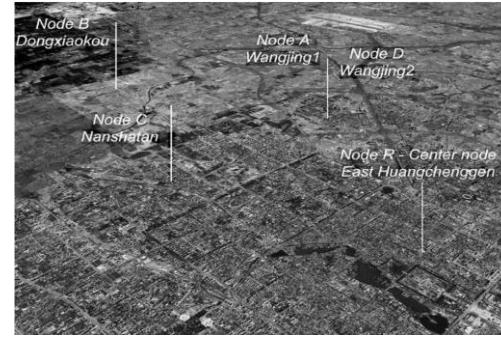
Boston 2002



Vienna 2003



Beijing 2009



Geneva 2009



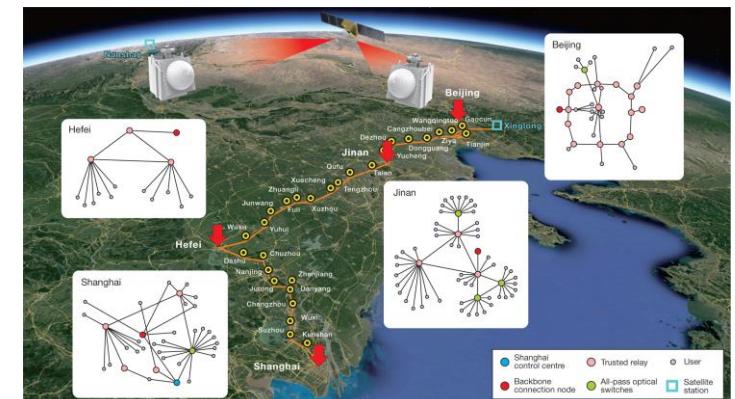
Tokyo 2010



UK 2015



China 2017, 2021



Enabling the wide-scale deployment of quantum cryptography

Distance

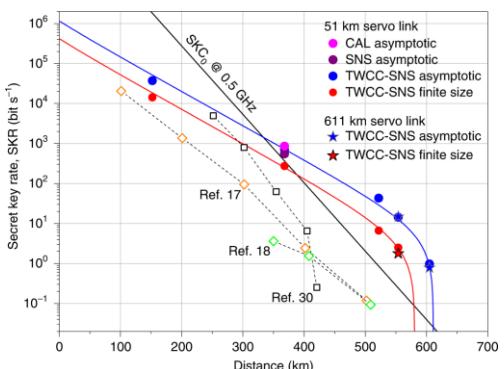
Secret key capacity bound

Photon loss vs distance

Limit on key rate

► Satellite-QKD

► TF-QKD



Pittaluga et al.,
Nat. Photon. **15**, 530–535 (2021)

Scalability & cost

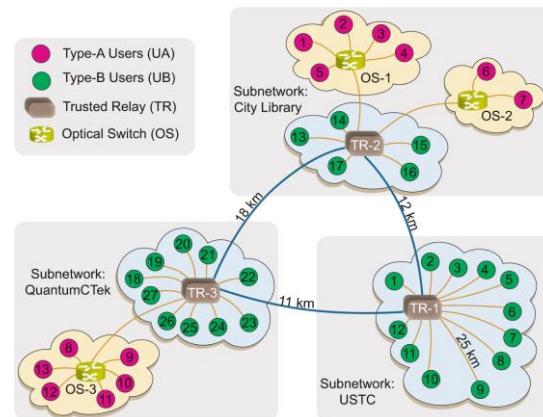
Coherent optical
comms networks:

High density

High connectivity

► Multi-node QKD
networks

► Trusted-node
architectures



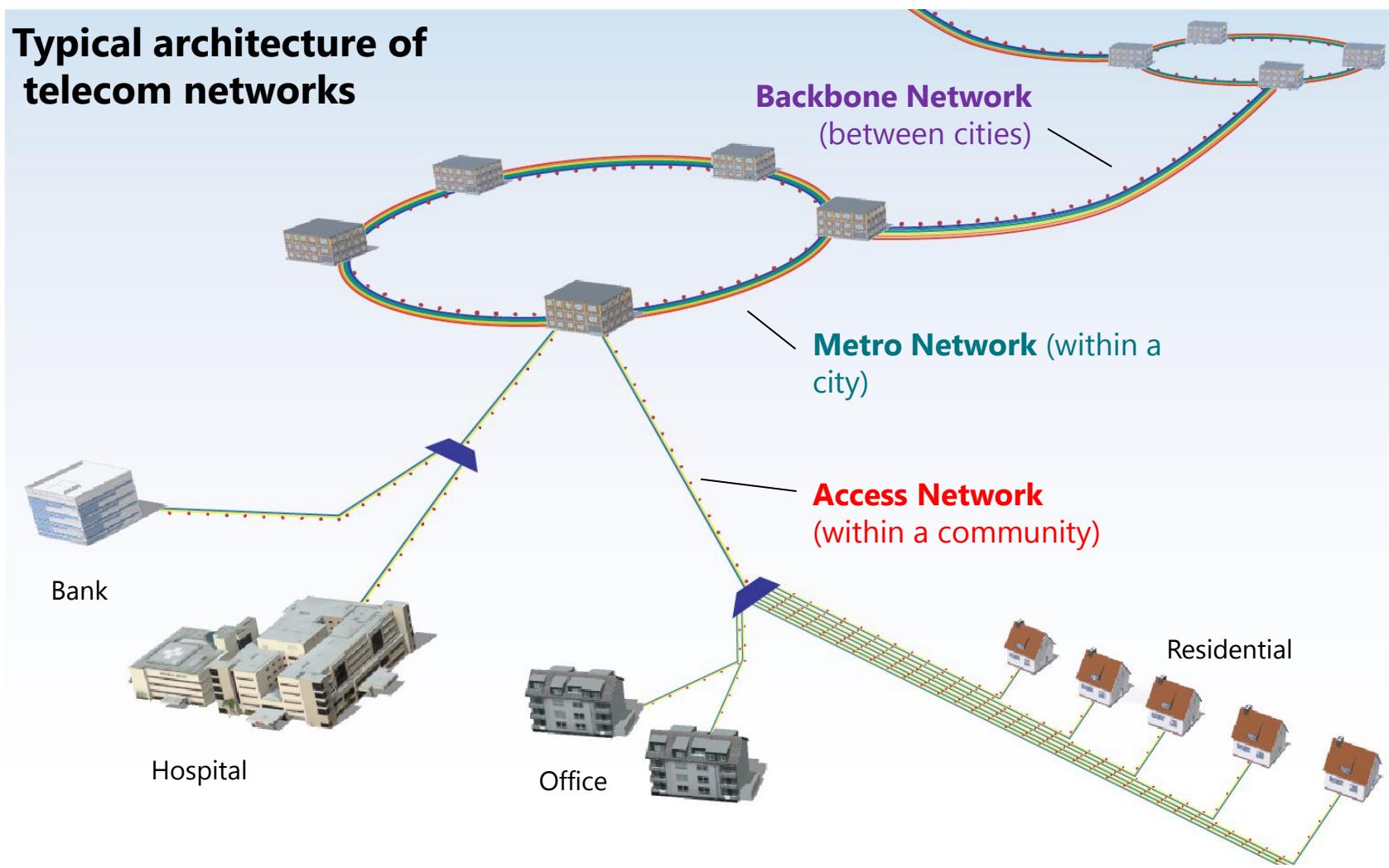
Chen et al.,
npj Quantum Information 7:134 (2021)

QKD Deployment – Main challenges

Enabling the wide-scale deployment of quantum cryptography

- More than 50% of the global population within metro & access areas
 - High density and connectivity
 - Route to practical deployment of QKD in these networks
-
- **Bandwidth**
 - **Loss/Distance**
 - **Production, operation and deployment costs**
-
- Multiplexing, higher clock rates
 - Trusted relay nodes
 - Power efficient information encoding
-
- ➔ Volume production and scalability
 - ➔ Compatibility with coherent optical comm. infrastructure

Typical architecture of telecom networks



Integrated Quantum Photonics

CORE QKD FUNCTIONS ON CHIP

QKD Transmitters (QTx) chips

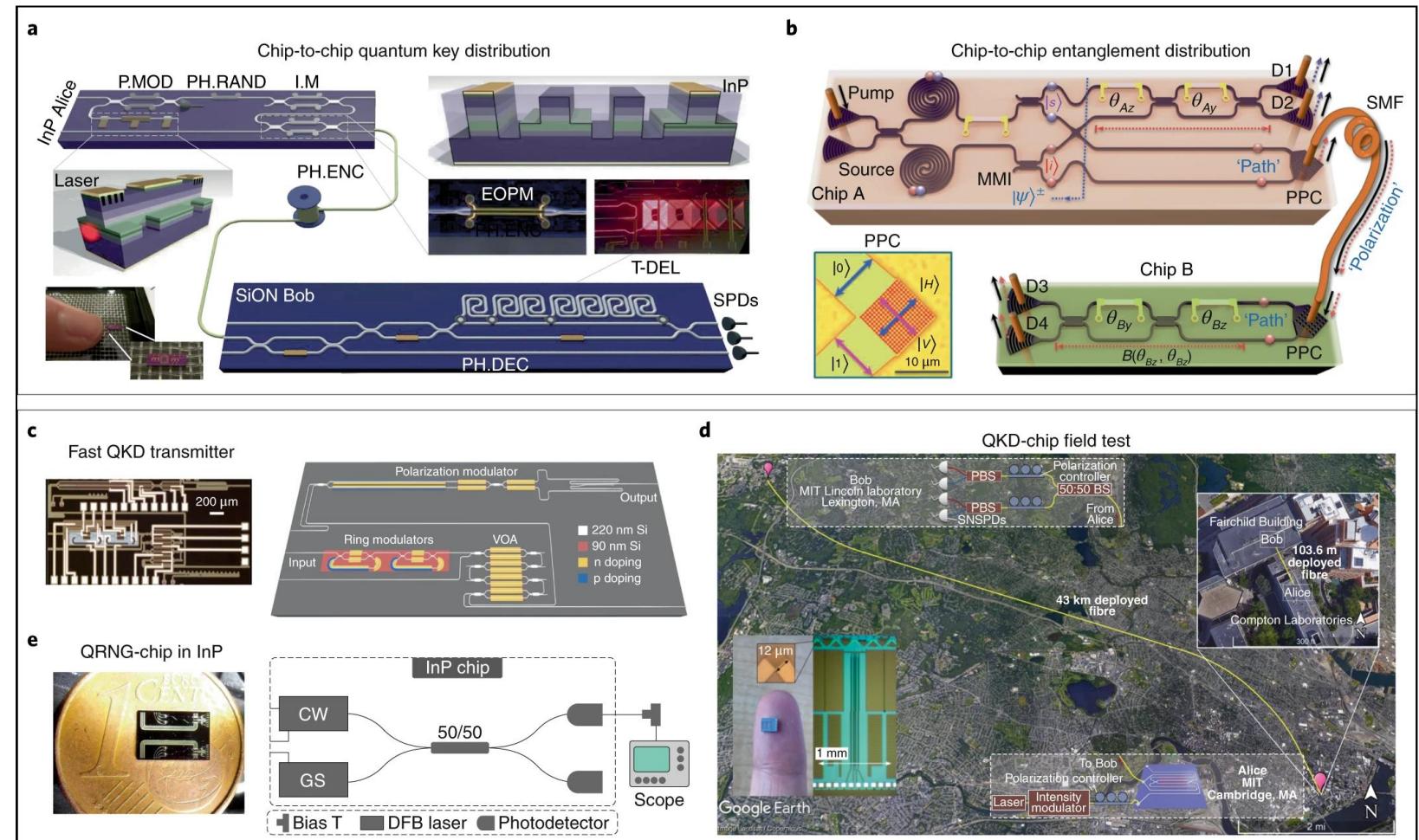
- Polarization/Phase encoding
- Fully integrated
- External light sources, intensity modulation

QKD Receiver (QRx) chips

- Low loss interferometers
- Path demodulators

Quantum Random number Generator (QRNG) chips

- Balance homodyne QRNGs
- Interferometric QRNGs



Wang, J., Sciarrino, F., Laing, A. et al. Integrated photonic quantum technologies. *Nat. Photonics* **14**, 273–284 (2020)
The rise of integrated quantum photonics. *Nat. Photonics* **14**, 265 (2020)

QKD transmitter chip demonstrations: a survey

	Si/InP	Protocol	Encoding	Laser source	Receiver	Phase Modulation	Quantum Random	Real-time	Clock rate	Bit rate @ channel loss
Ma et al. <i>Optica</i> 3 , 11 (2016)	Si	BB84	Polarization	Discrete optics	Fibre	Carrier depletion (CDM)	No	No	10 MHz	1 kbps [@1dB, APD]
Sibson et al. <i>Nat Commun</i> 8 , 13984 (2017)	InP	BB84, DPS, COW	Time-bin	On-chip	Si chip	Traveling wave EOPM	Yes	No	0.56 GHz [BBB84] 1.76 GHz [DPS]	345 kbps [4 dB, SNSPD] 565 kbps [4dB, SNSPD]
Sibson et al. <i>Optica</i> 4 , 172 (2017)	Si	BB84, COW	Time-bin Polarization	Discrete optics	Si chip	CIM	No	No	1 GHz 0.86 GHz	329 kbps [4 dB, SNSPD] 916 kbps [4 dB, SNSPD]
Ding et al. <i>npj Quantum Inf</i> 3 , 25 (2017)	Si	High-Dim. QKD	Path entanglement	Discrete optics	Si chip	TOPM	No	Yes	5 kHz / 10 kHz	[0.65 bit / photon]
Bunandar et al. <i>Phys Rev X</i> 8 , 021009 (2018)	Si	3-state BB84	Polarization	Discrete optics	Si chip	CDM	No	Yes	625 MHz	864 kbps [SNSPD] 157 kbps [16 dB, field trial]
❖ Paraiso et al. <i>npj Quantum Inf</i> 5 , 42 (2019)	InP	BB84, DPS	Time-bin	On-chip	Si chip	Phase-seeding	Yes	No	1 GHz	840 kbps [10 dB, APDs]
Zhang et al. <i>Nat. Photonics</i> 13 , 839 (2019)	Si	CV-QKD	Gaussian-modulated	Discrete optics	Si chip	CDM	No	Yes	1-10 MHz	0.14 kbps [16 dB, BHD]
Avesani et al. arXiv:1907.10039v1 (2019)	Si	3-state BB84, free space	Polarization	Discrete optics	Fibre	CDM	No	No	50 MHz	30 kbps [free space]
Geng et al. <i>Opt Express</i> 27 , 29045 (2019)	Si	BB84	Time-bin	Discrete optics	Si chip	CDM	No	No	100 MHz	85 kbps [4dB, SNSPD]
Cao et al. <i>Phys Rev Applied</i> 14 , 011001 (2020)	Si	MDI-QKD	Polarization	Discrete optics	Si chip	CDM	NA	No	0.5 MHz	[2.9 x 10-6 / pulse, SNSPD]
Semenenko et al. <i>Optica</i> 7 , No. 3 (2020)	InP	MDI-QKD	Time-bin	On-chip	Si chip	Traveling wave EOPM	Yes	No	250 MHz	1 kbps [20 dB, SNSPD]
Wei et al. <i>Phys Rev X</i> 10 , 031030 (2020)	Si	MDI-QKD	Polarization	Discrete optics	Fibre	CDM	Gl. phase	Yes	1.25 GHz	0.5 kbps [27 dB, SNSPD]

System integration challenges

- ✓ Pioneering proof-of-concept demonstrations: → capability confirmed
- ⇒ **Complete standalone chip-based system still missing ?**

Numerous challenges to tackle at once

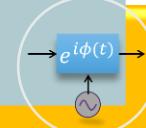
- Bit, basis choices
- Global phase randomization
- Decoy intensities
- Biased intensities
- **High bit rate QRNG**

Quantum random number generator



- Time-bin and polarization encoding
- Intensity modulation MZM
- Number of RF channels
- EOPM footprint on chip
- Low V_π for CMOS level compatibility

Phase modulation technique



- Compact driving & processing electronics
- Power consumption
- Thermal management
- Co-design optical chips and control electronics

Remove lab equipment for driving/processing



- Photonic **packaging**
- Optoelectronic assembly
- Clock distribution and **synchronization**
- **Stability** – feedback control
- Long term operation

System integration



- Real-time random choice variables
- Real time public communication
- Error-correction, Privacy amplification
- **Data-encryption**

Real-time operation

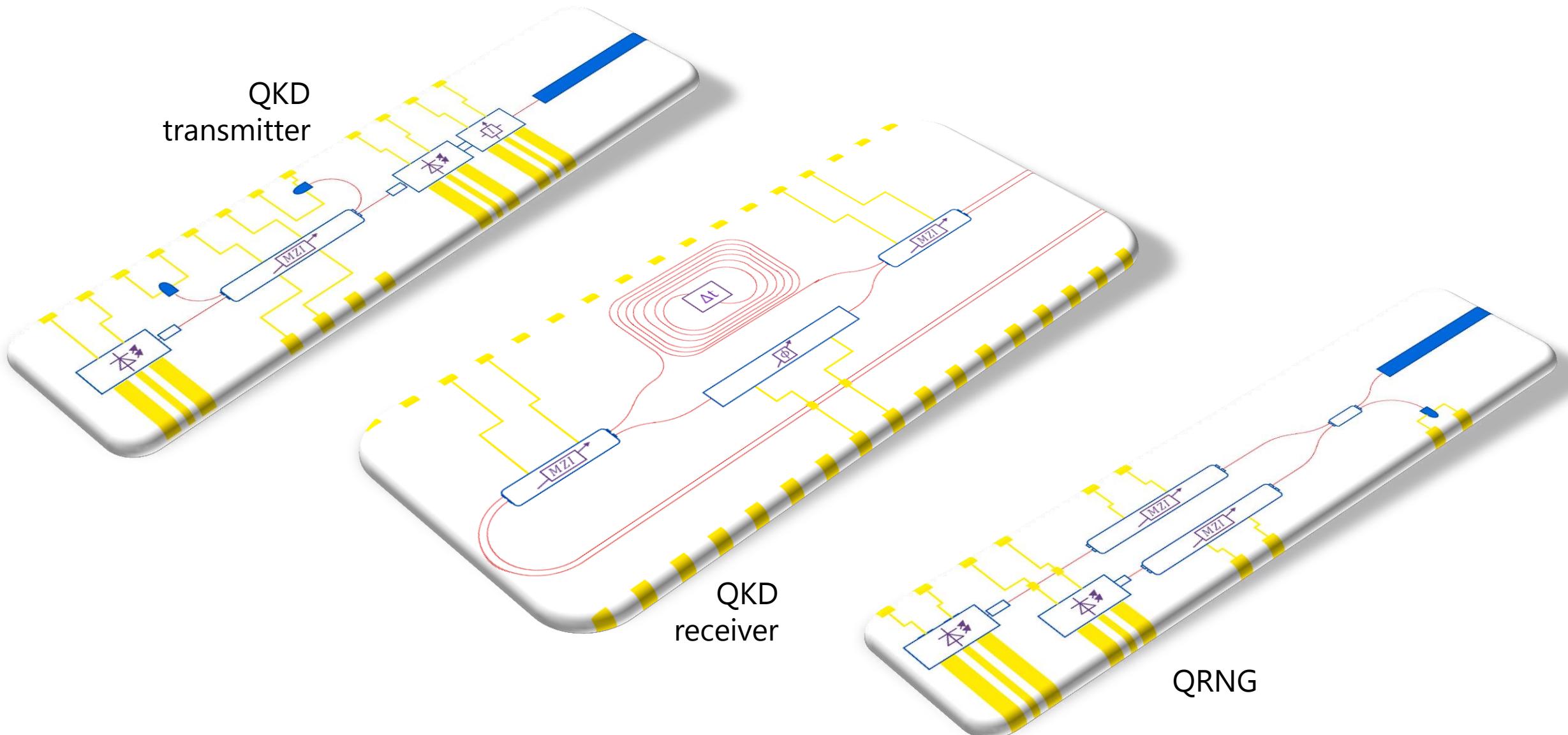


quantum secure

power efficient

deployable units

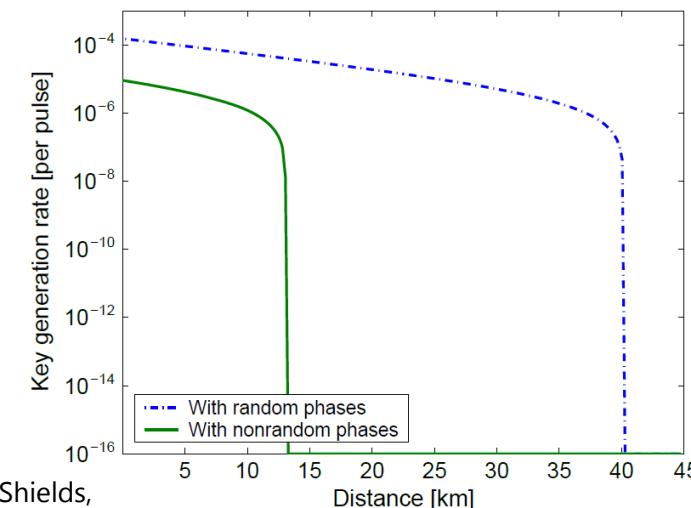
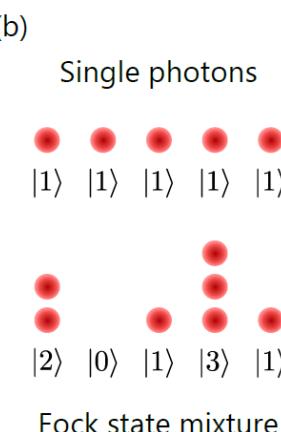
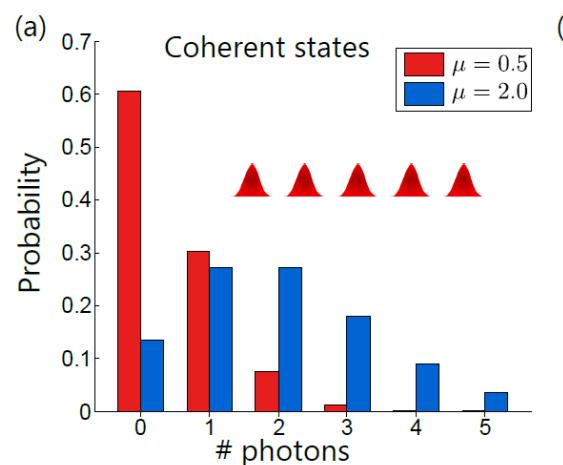
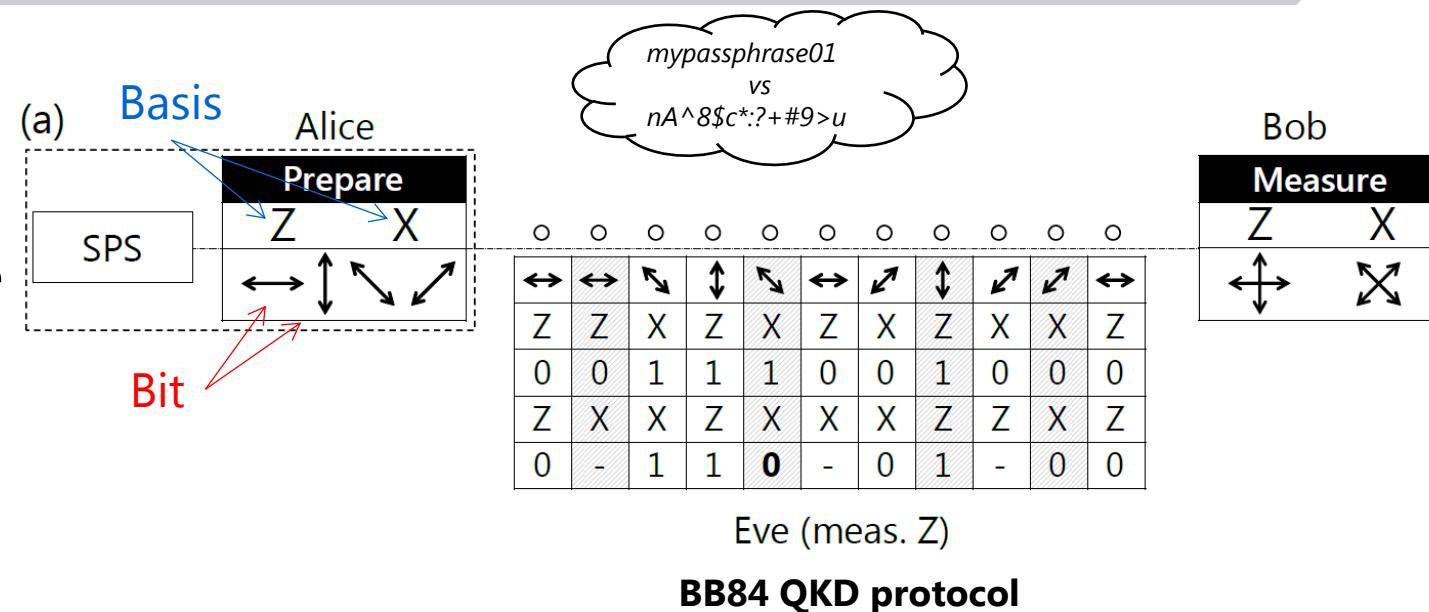
Core Function QKD Chips



QUANTUM RANDOM NUMBERS ON CHIP

Photonic ICs for QKD: Quantum Random Number Generator

- Information theoretic security
 - Random choices of bit, bases
 - Decoy state: random intensity choice
- Global phase randomisation
 - Weak coherent pulses
⇒ Retrieve physics of single photons
- Pseudo-random numbers:
 - Not suitable for QKD

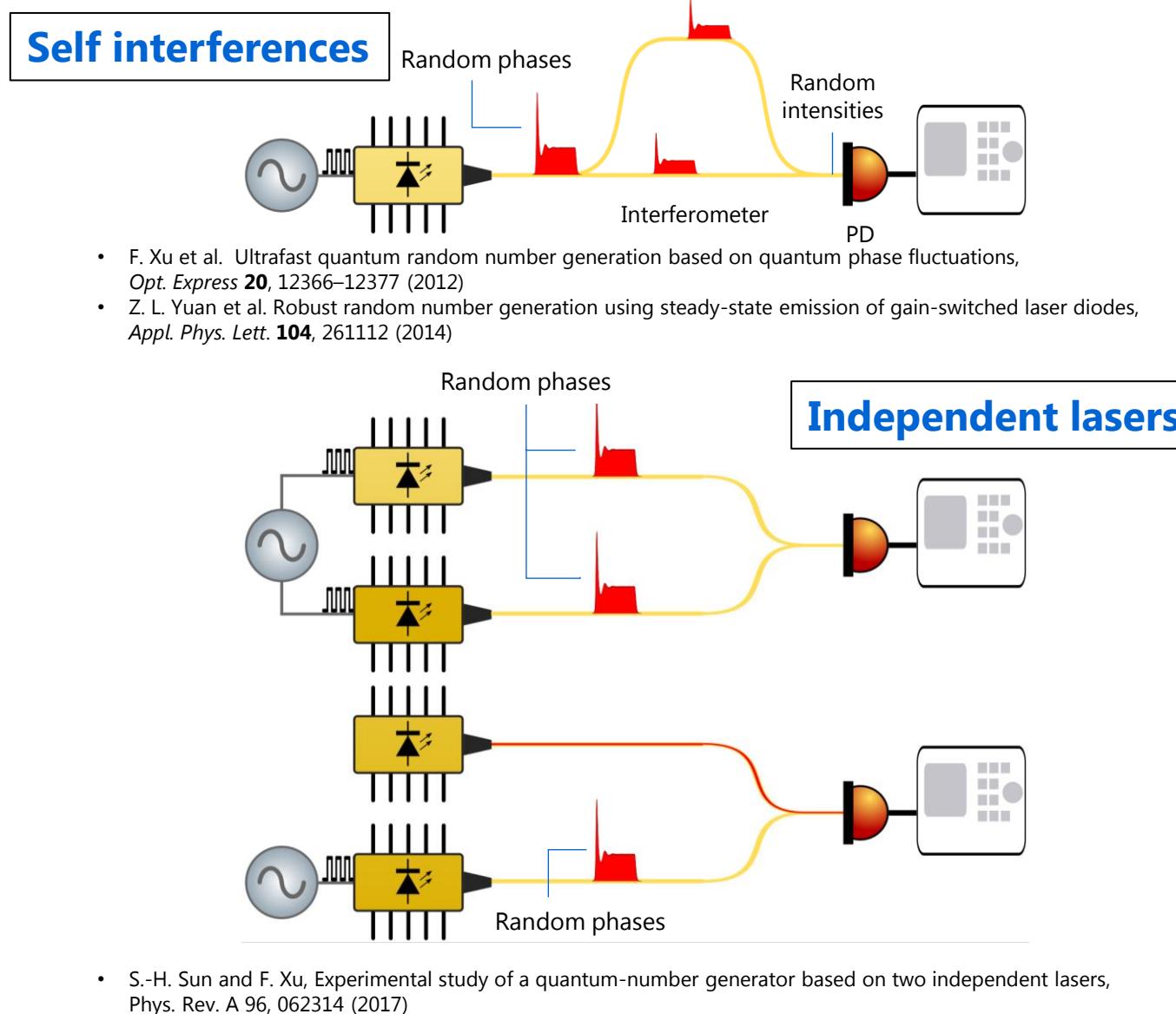


T.K. Paraiso, R.I. Woodward, D. G. Marangon, V. Lovic, Z.-L. Yuan and A.J. Shields,
Advanced Laser Technology for Quantum Communications (Tutorial Review)
Advanced Quantum Technologies 4, 2100062 (2021)
H. K. Lo and J. Preskill, Quant. Inf. Comput. 8, 431–458 (2007)

quantum secure

Photonic ICs for QKD: Quantum Random Number Generator

- Information theoretic security
 - Random choices of bit, bases
 - Decoy state: random intensity choice
- Global phase randomisation
 - Weak coherent pulses
⇒ Retrieve physics of single photons
- Gain switching in laser diodes
 - Spontaneous emission noise
 - Quantum phase fluctuations
 - Quantum source of entropy



quantum secure

Photonic ICs for QKD: Quantum Random Number Generator

QRNG CHIPS

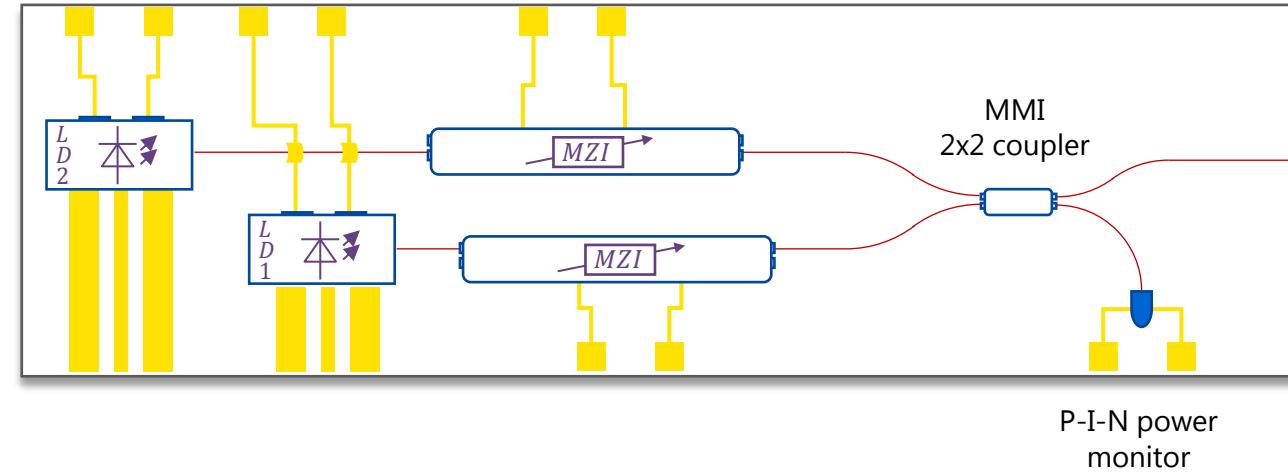
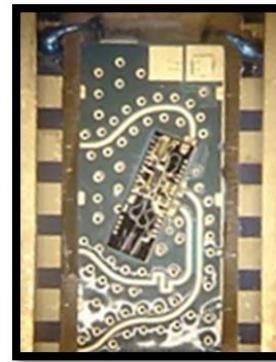
Active: InP

Entropy source:
Spontaneous emission

Measurement:
Dual-DFB interference

Clock-rate: 1 GHz

Chip footprint
2 mm x 6 mm



Photonic ICs for QKD: Quantum Random Number Generator

QRNG CHIPS

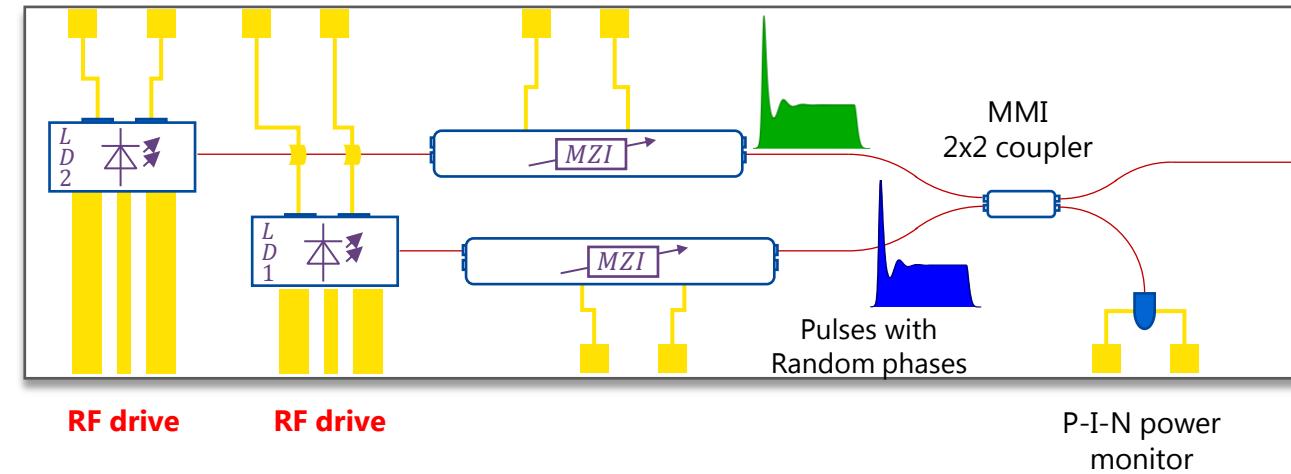
Active: InP

Entropy source:
Spontaneous emission

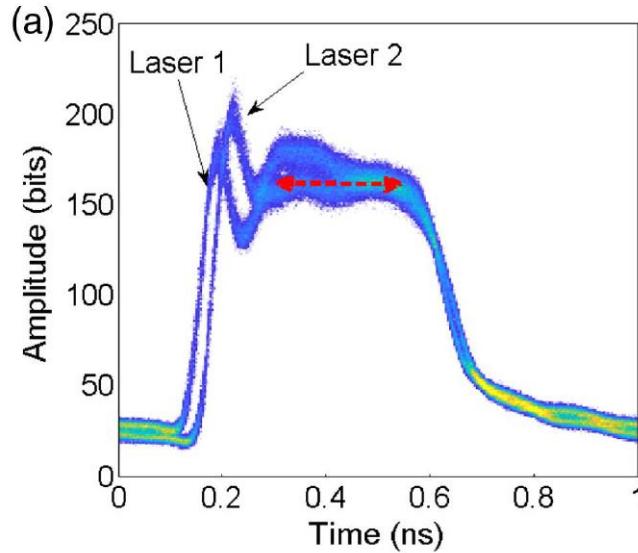
Measurement:
Dual-DFB interference

Clock-rate: 1 GHz

Chip footprint
2 mm x 6 mm



Adjust temporal delay



Photonic ICs for QKD: Quantum Random Number Generator

QRNG CHIPS

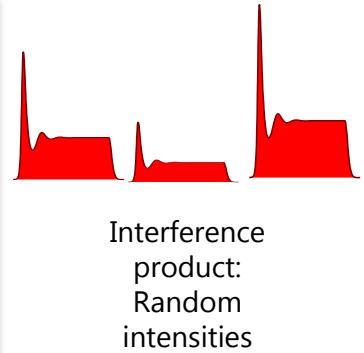
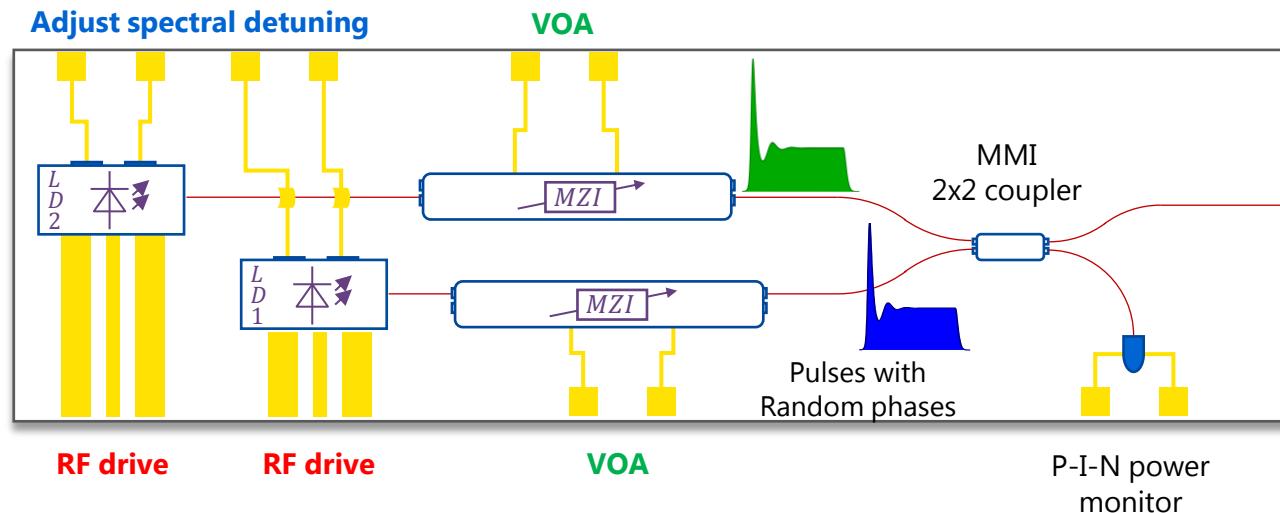
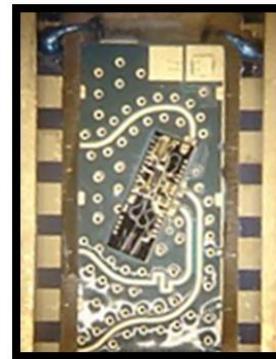
Active: InP

Entropy source:
Spontaneous emission

Measurement:
Dual-DFB interference

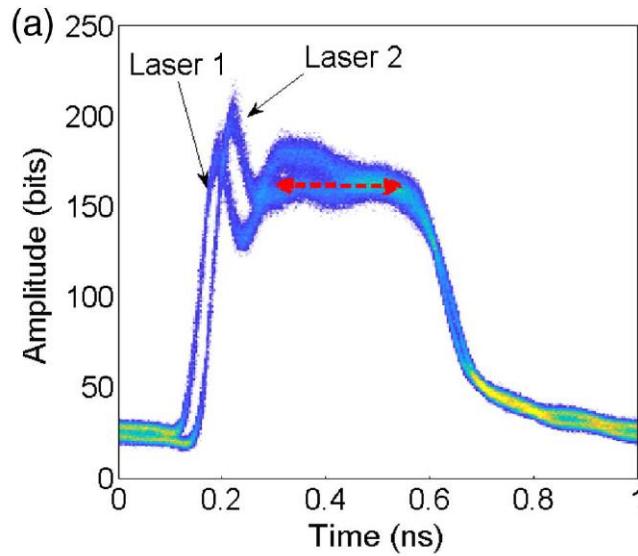
Clock-rate: 1 GHz

Chip footprint
2 mm x 6 mm

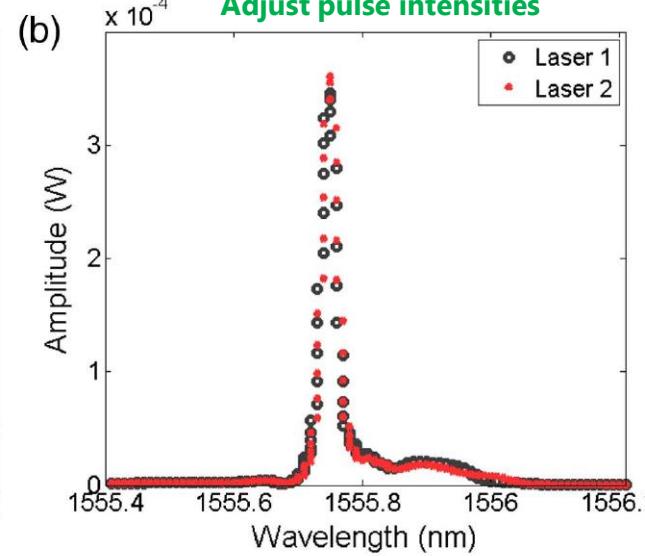


Interference product:
Random intensities

Adjust temporal delay



Adjust spectral detuning
Adjust pulse intensities



Photonic ICs for QKD: Quantum Random Number Generator

QRNG CHIPS

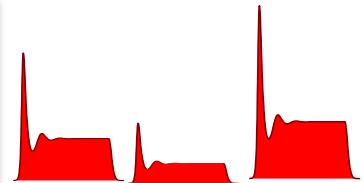
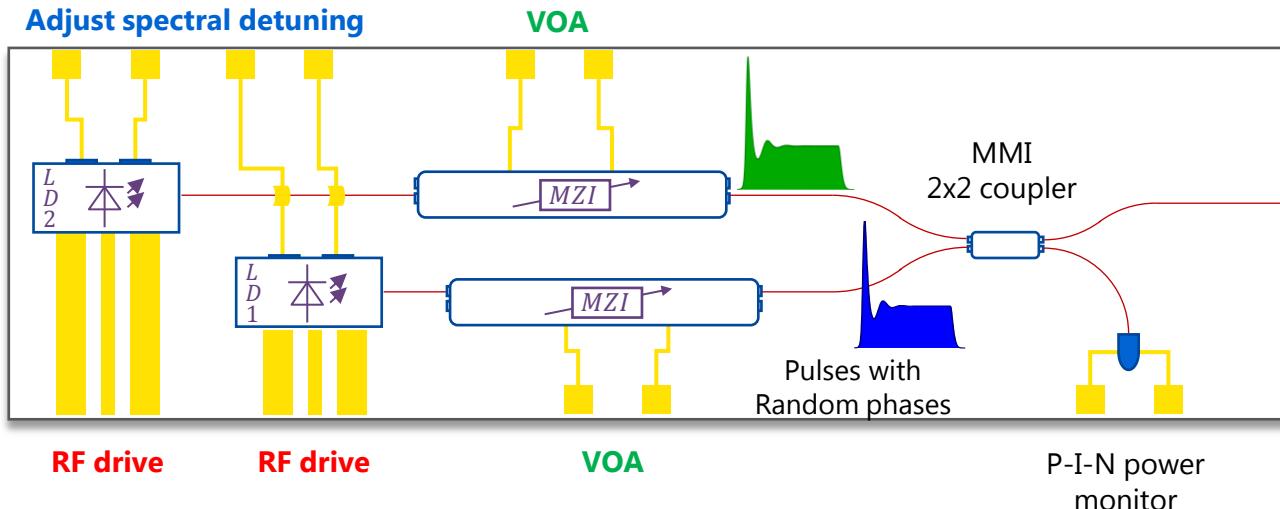
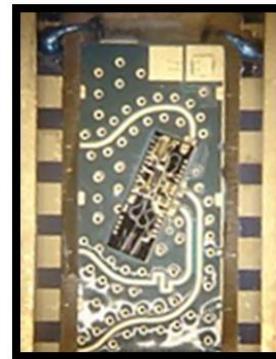
Active: InP

Entropy source:
Spontaneous emission

Measurement:
Dual-DFB interference

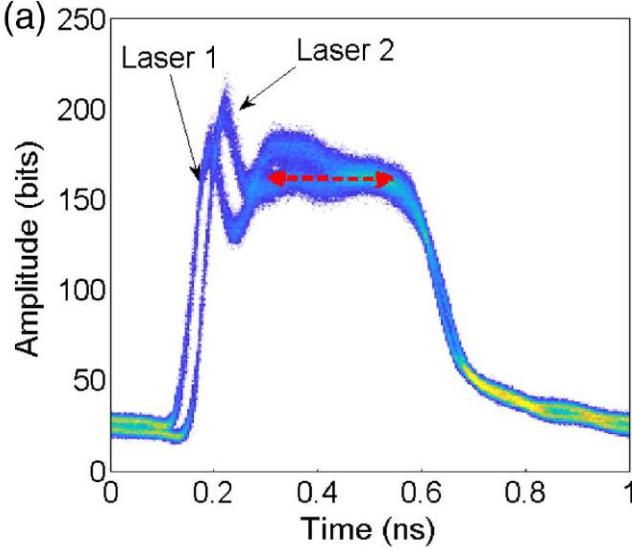
Clock-rate: 1 GHz

Chip footprint
2 mm x 6 mm

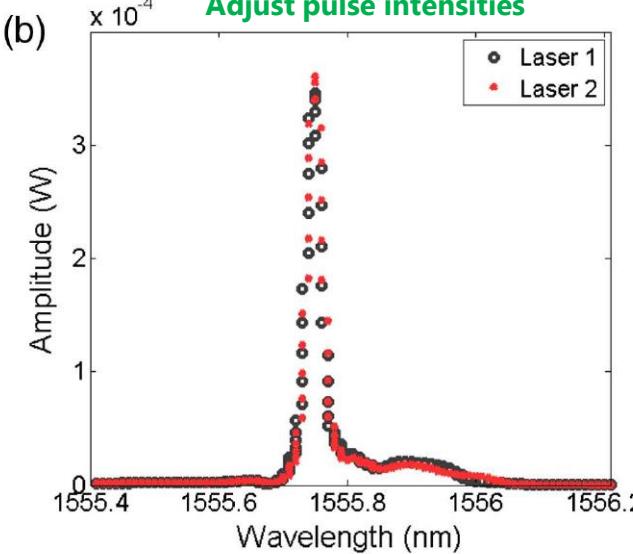


Interference product:
Random intensities

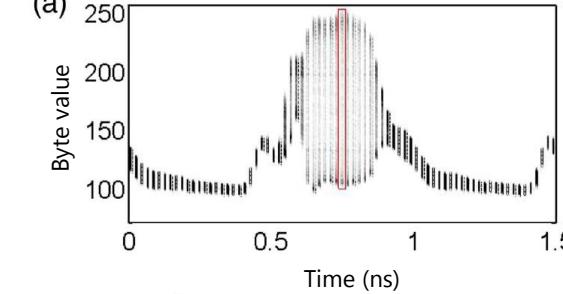
Adjust temporal delay



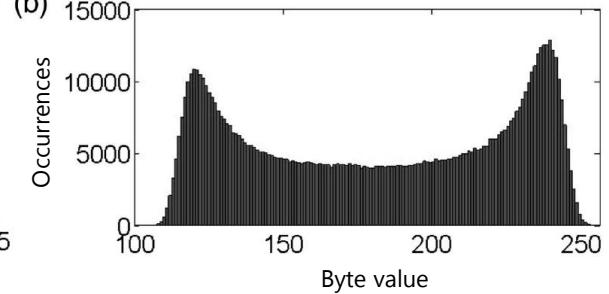
Adjust spectral detuning Adjust pulse intensities



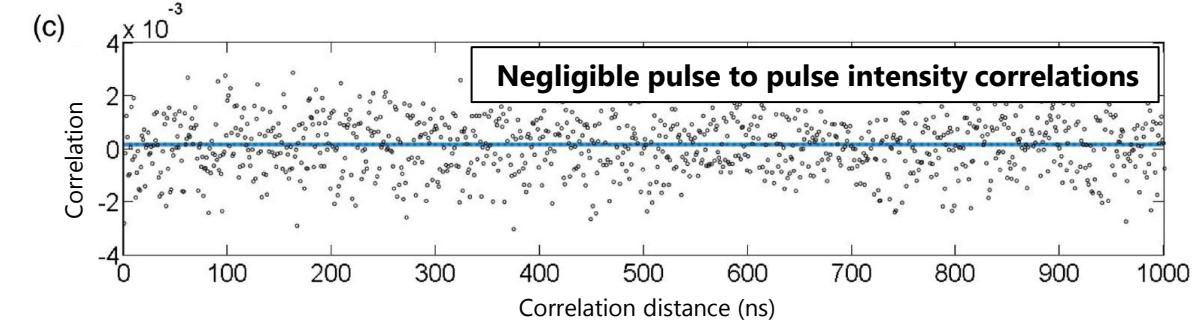
Time integrated pulse intensity



Double-peaked histogram



Negligible pulse to pulse intensity correlations



Photonic ICs for QKD: Quantum Random Number Generator

QRNG CHIPS

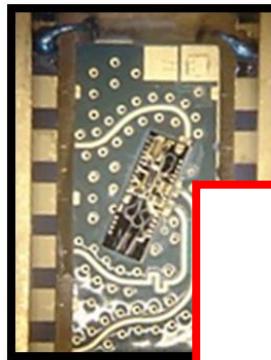
Active: InP

Entropy source:
Spontaneous emission

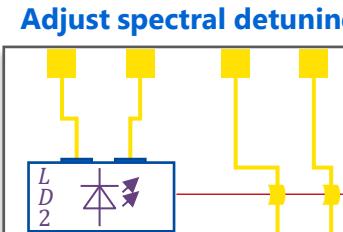
Measurement:
Dual-DFB interference

Clock-rate: 1 GHz

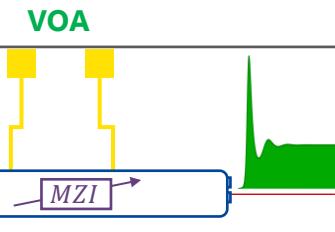
Chip footprint
2 mm x 6 mm



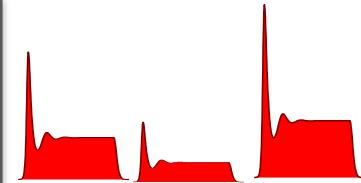
Adjust spectral detuning



VOA



MMI
2x2 coupler



Interference
product:
Random
intensities

**High-bit
rate**
4 Gbit/s

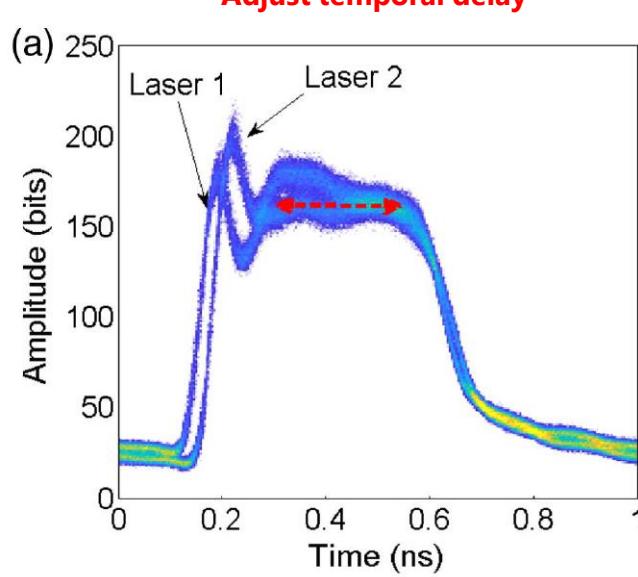
BB84@1GHz clock

1 bit \rightarrow state {0,1}
1 bit \rightarrow basis {X, Y}
2 bits \rightarrow int {S, D, V}

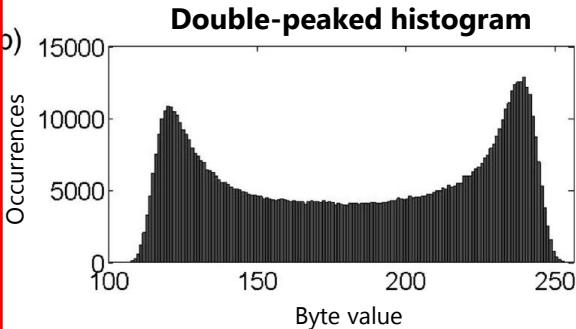
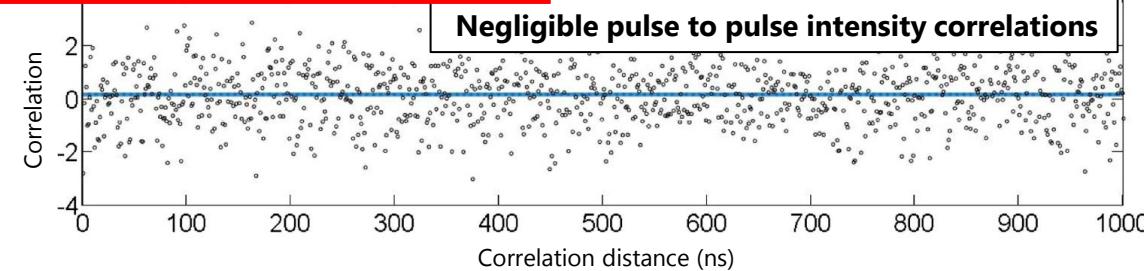
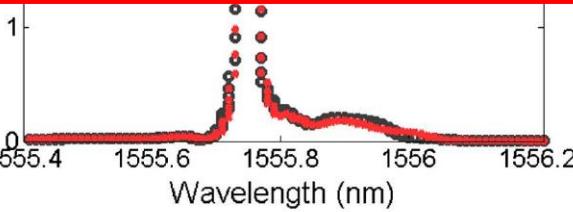
Table 1. Results of the NIST Test Battery Applied on 10^3 Strings, Each Having a Length of 10^6 Bits

Statistical Test	P Value	Proportion	Result
Frequency	0.9061	0.989	Success
Block frequency	0.0835	0.992	Success
Cumulative sums	0.8817	0.986	Success
Cumulative sums	0.39	0.989	Success
Runs		0.986	Success
Longest run		0.992	Success
Rank		0.986	Success
FFT		0.993	Success
Nonoverlapping tem	0.5045	0.990	Success
Overlapping template	0.8343	0.983	Success
Universal	0.1238	0.987	Success
Approximate entropy	0.3330	0.990	Success
Random excursions	0.4151	0.989	Success
Random excursions variant	0.4882	0.992	Success
Serial	0.2012	0.990	Success
Serial	0.4101	0.995	Success
Linear complexity	0.3361	0.992	Success

PASSED



(b)



QKD TRANSMITTER CHIP

Photonic ICs for QKD: Quantum Transmitter

QTx CHIP

Active: InP

Protocol:

Time-bin decoy BB84

Modulation:

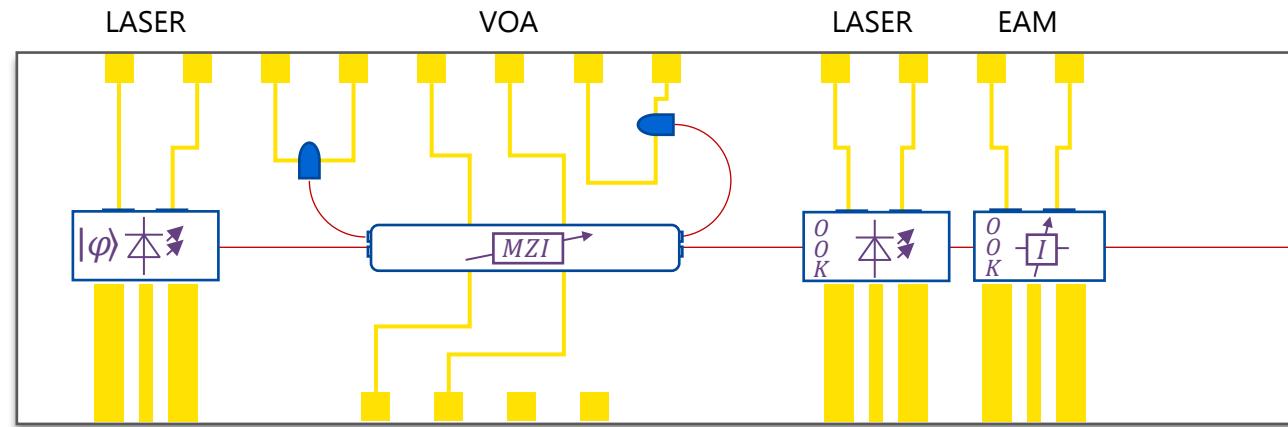
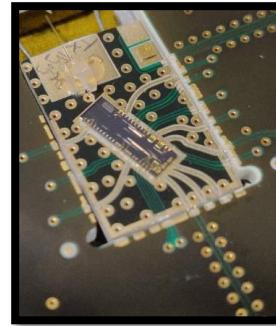
Phase-seeding

Multi-level, OOK

Clock-rate: 1 GHz

Chip footprint

2 mm x 6 mm



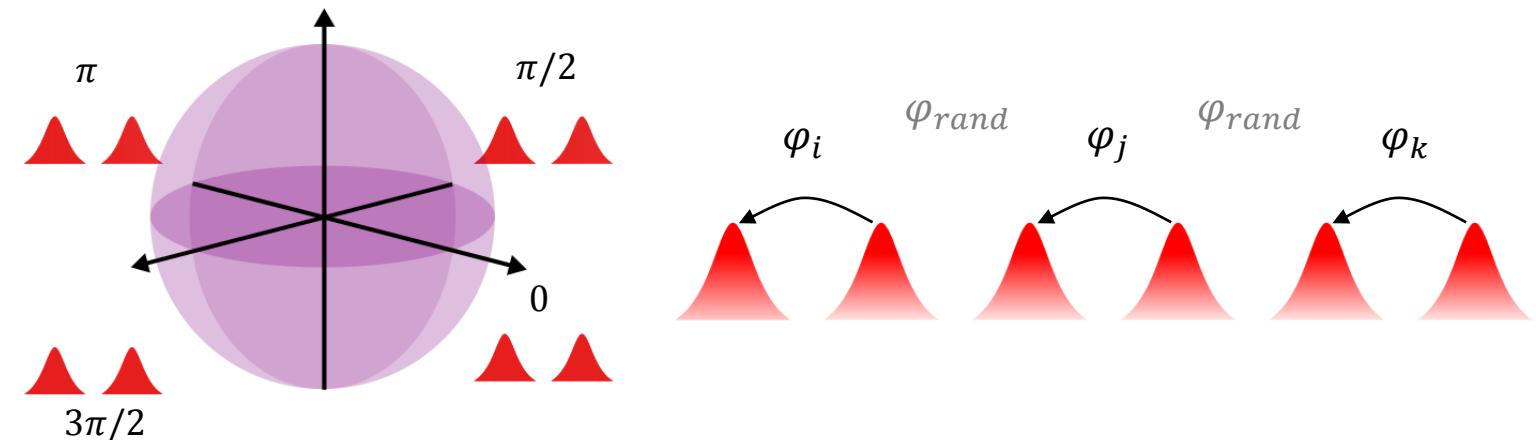
Phase-seeding = optical injection locking with phase preparation

T Paraiso, R Woodward, D. Marangon et al. Advanced Laser Technology for Quantum Communications
Adv Quant Comm, in press (2021)

Time-bin BB84 protocol: 2 bases, 2 states

4 differential phase states: $\{0, \pi\}$, $\{\frac{\pi}{2}, \frac{3\pi}{2}\}$

Global phase randomisation



Photonic ICs for QKD: Quantum Transmitter

QTx CHIP

Active: InP

Protocol:

Time-bin decoy BB84

Modulation:

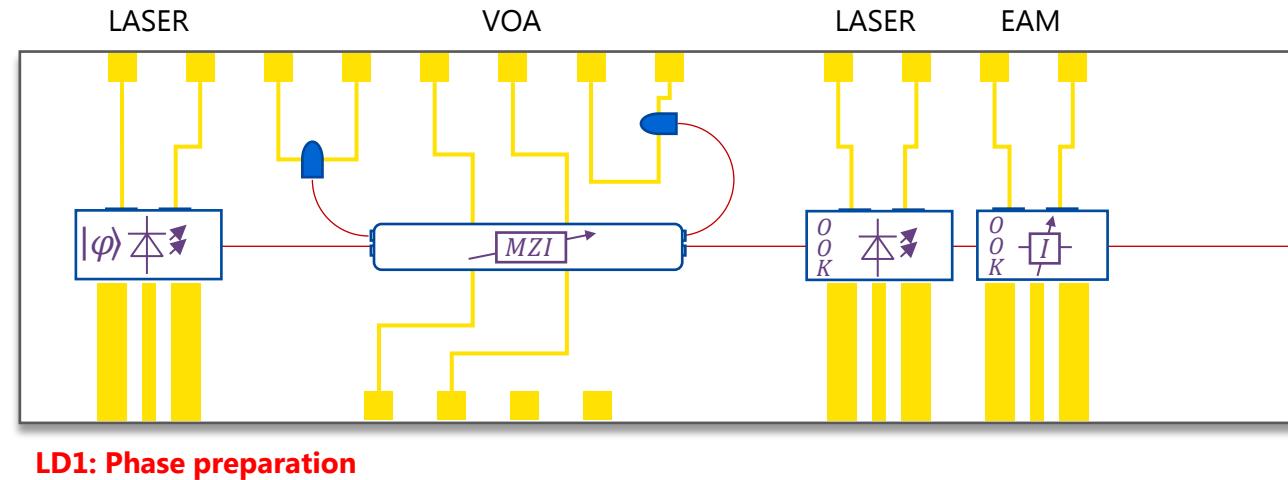
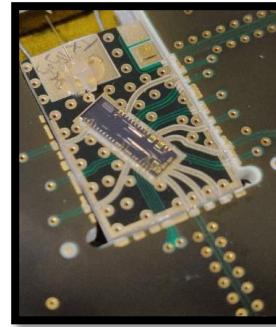
Phase-seeding

Multi-level, OOK

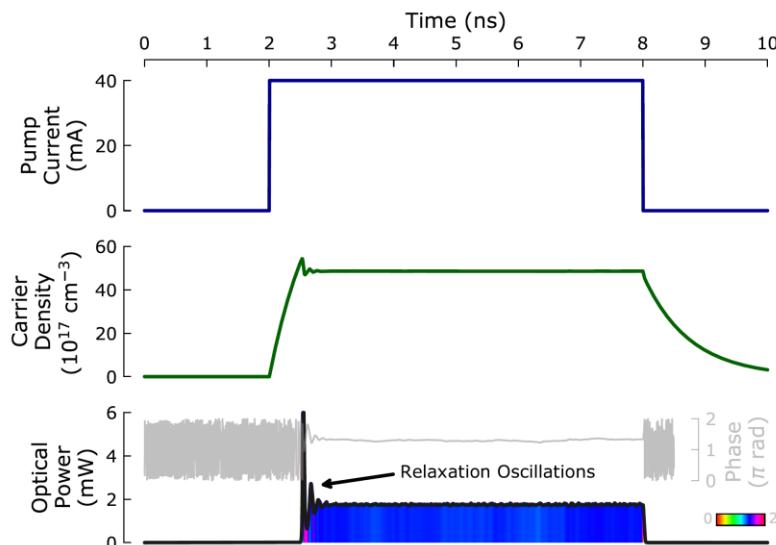
Clock-rate: 1 GHz

Chip footprint

2 mm x 6 mm

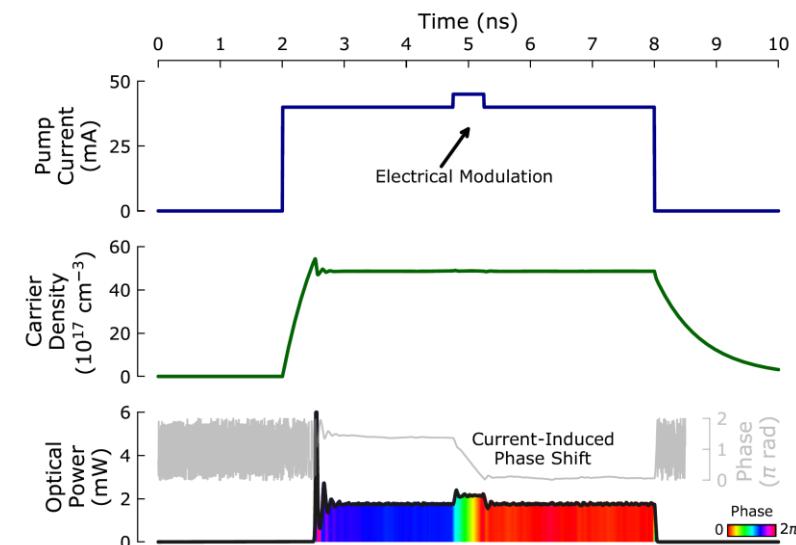


(1) Long coherent GS pulse



Phase preparation
via
Direct modulation

(2) Phase preparation



Photonic ICs for QKD: Quantum Transmitter

QTx CHIP

Active: InP

Protocol:

Time-bin decoy BB84

Modulation:

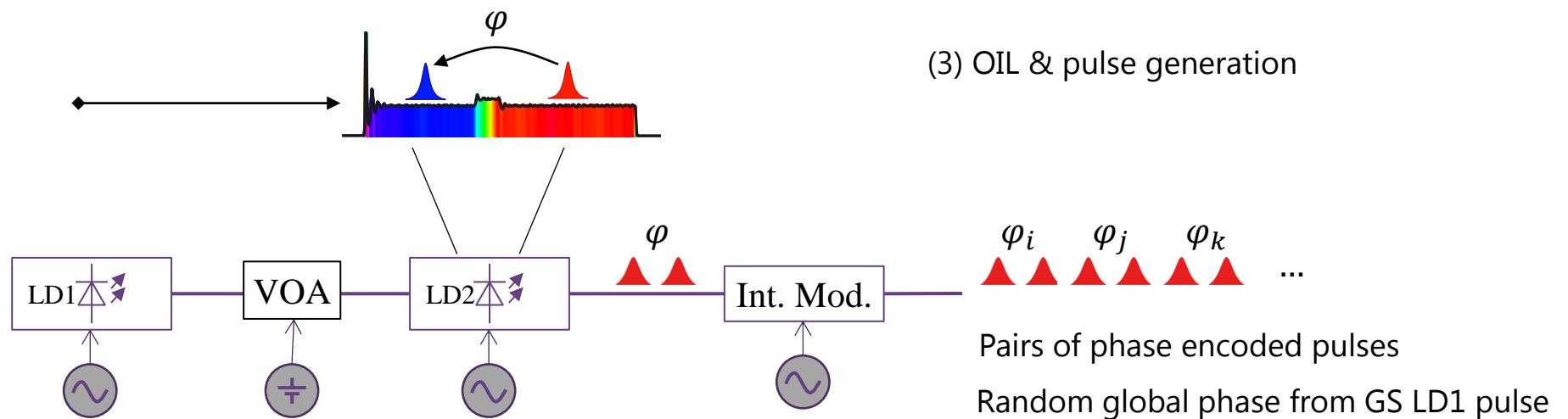
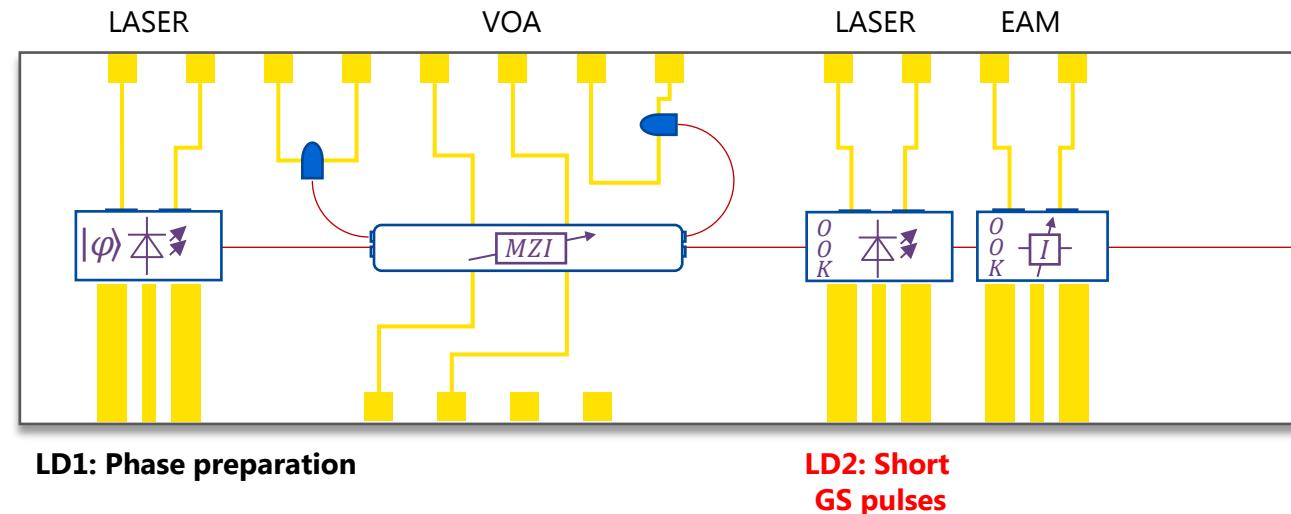
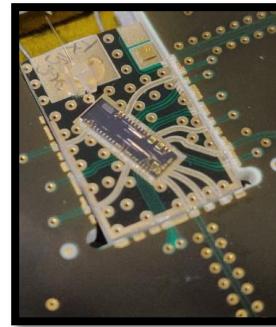
Phase-seeding

Multi-level, OOK

Clock-rate: 1 GHz

Chip footprint

2 mm x 6 mm



Photonic ICs for QKD: Quantum Transmitter

QTx CHIP

Active: InP

Protocol:

Time-bin decoy BB84

Modulation:

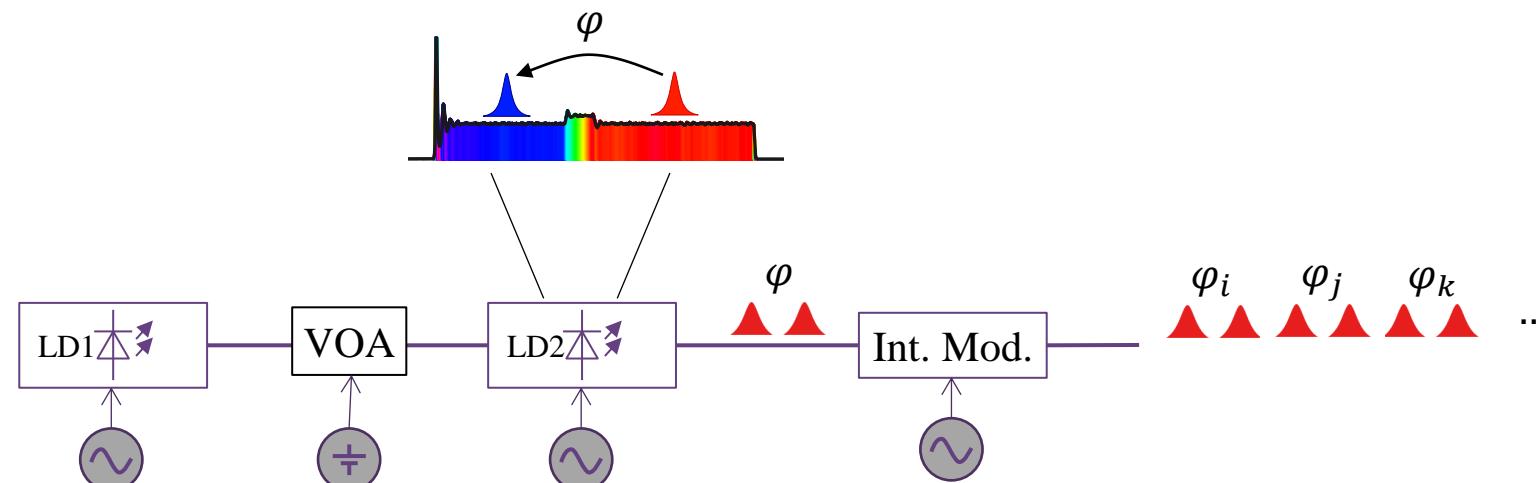
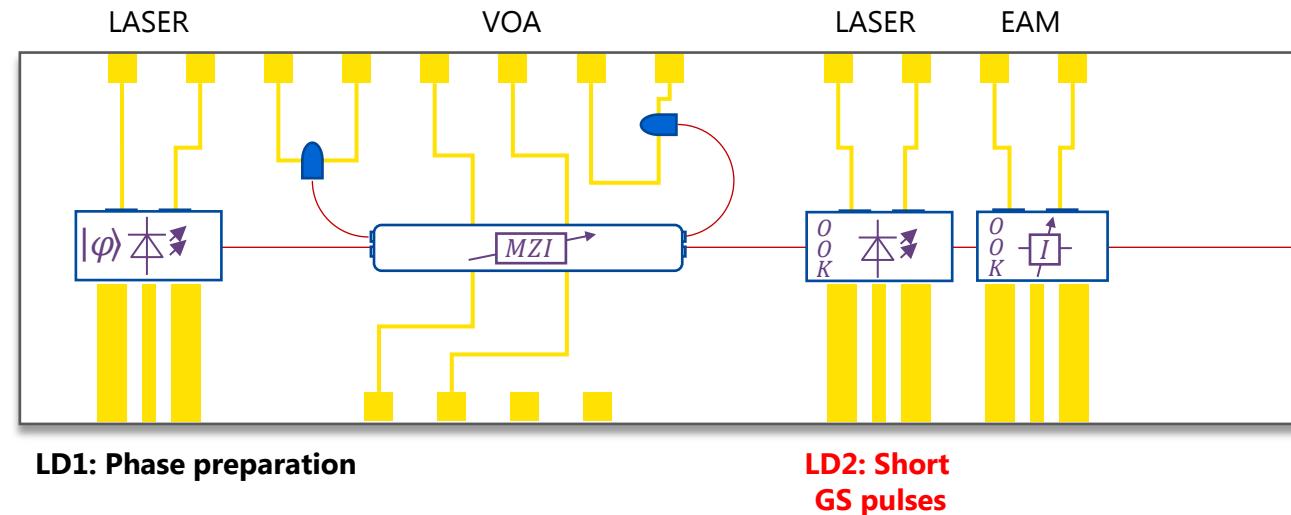
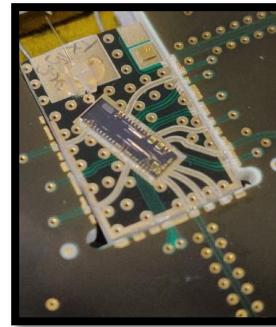
Phase-seeding

Multi-level, OOK

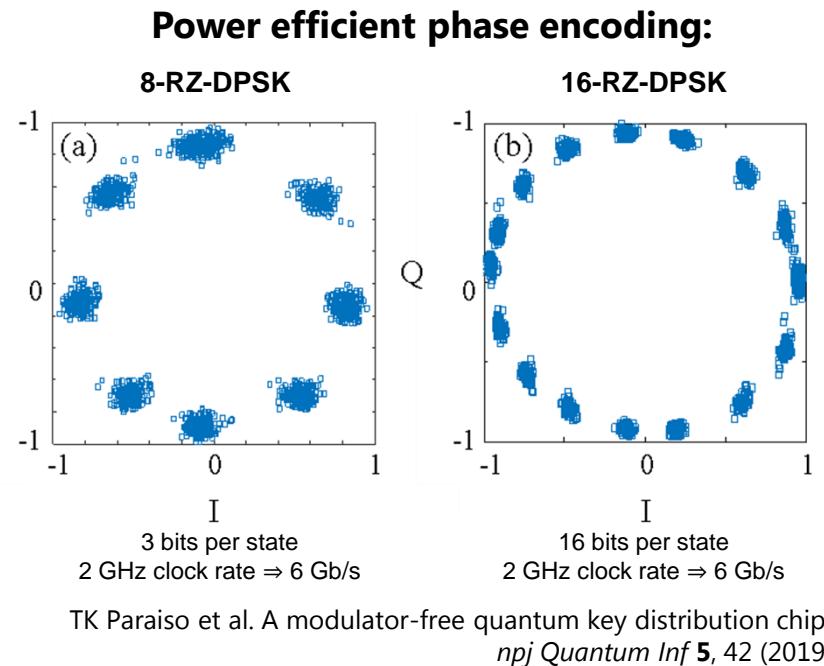
Clock-rate: 1 GHz

Chip footprint

2 mm x 6 mm



power efficient



Photonic ICs for QKD: Quantum Transmitter

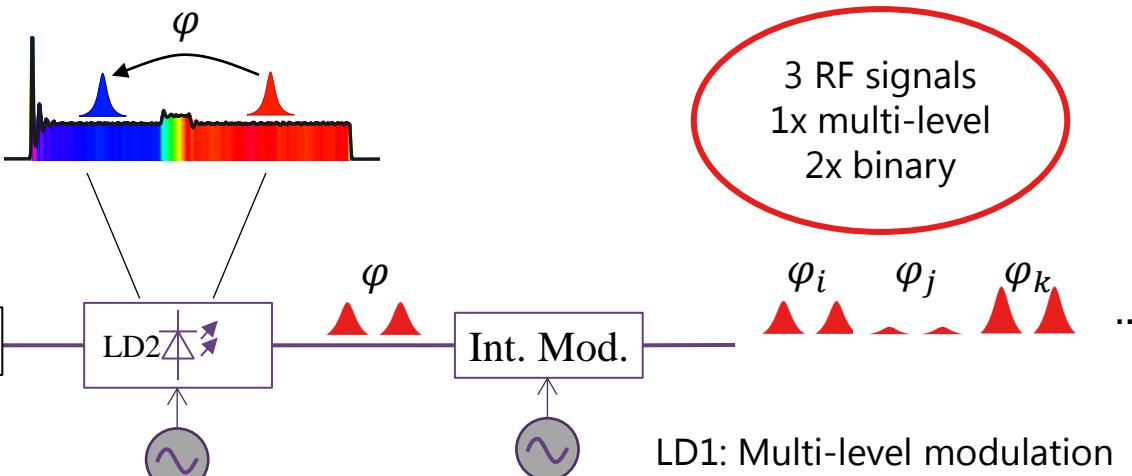
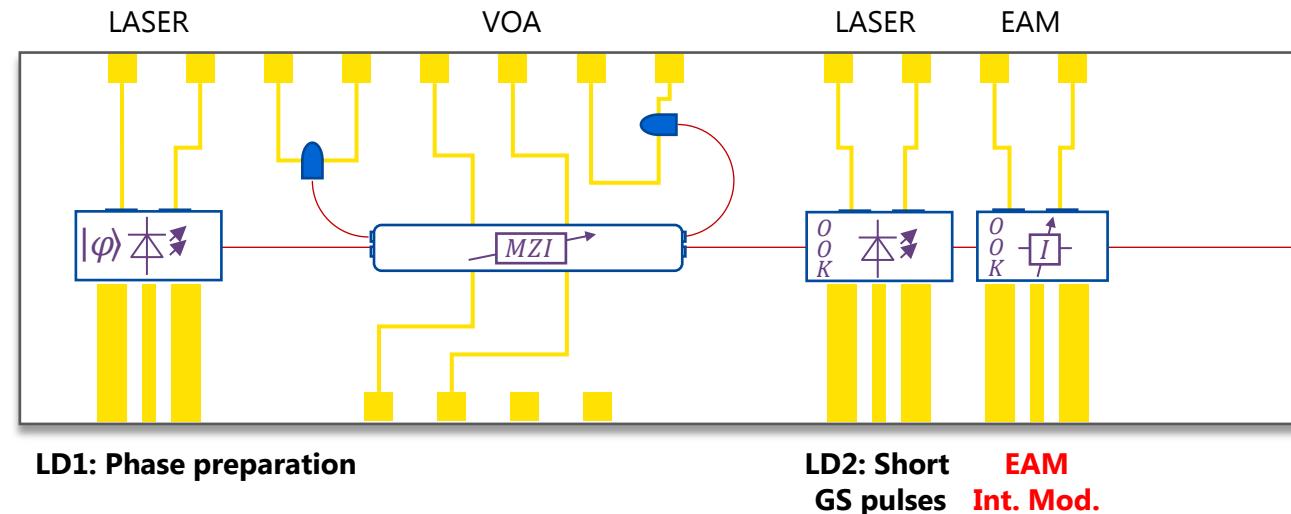
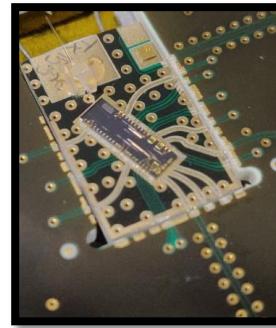
QTx CHIP

Active: InP
Protocol:
Time-bin decoy BB84

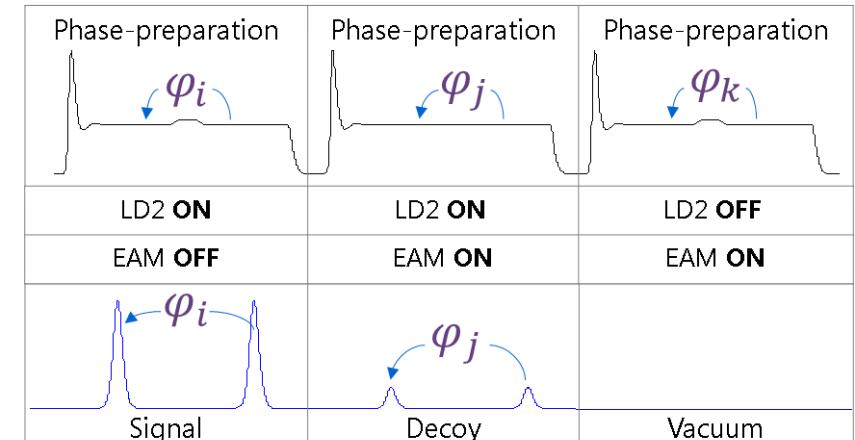
Modulation:
Phase-seeding
 Multi-level, OOK

Clock-rate: 2 GHz

Chip footprint
 2 mm x 6 mm



Power-efficient intensity encoding



LD2/EAM: interleaved binary modulation

QKD RECEIVER CHIP

Photonic ICs for QKD: Quantum Receiver

QRx CHIP

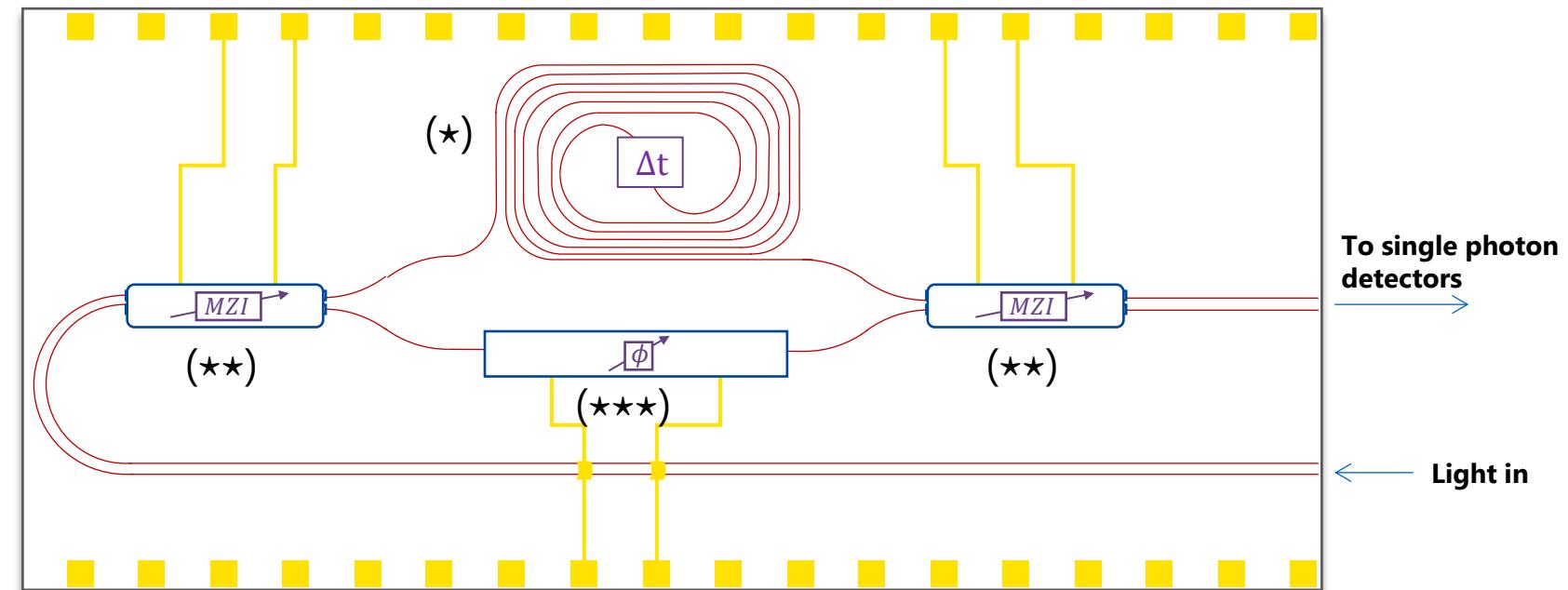
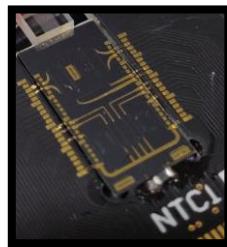
Passive: SiN/SiO₂

Decoding:
Delay-line MZI

Propagation losses:
~0.5 dB/cm

AMZI FSR: 2 GHz

Circuit footprint
4 mm x 8 mm



(★)

On-chip delay line 500 ps

(★★)

Loss compensation
Tunable MZI (thermo-optic)
Input beam-splitter loss compensation
Output beam-splitter fine tuning

(★★★)

Measurement basis
Phase tuning (thermo-optic)
Fast-modulation: external LiNb PM

Photonic ICs for QKD: Quantum Receiver

QRx CHIP

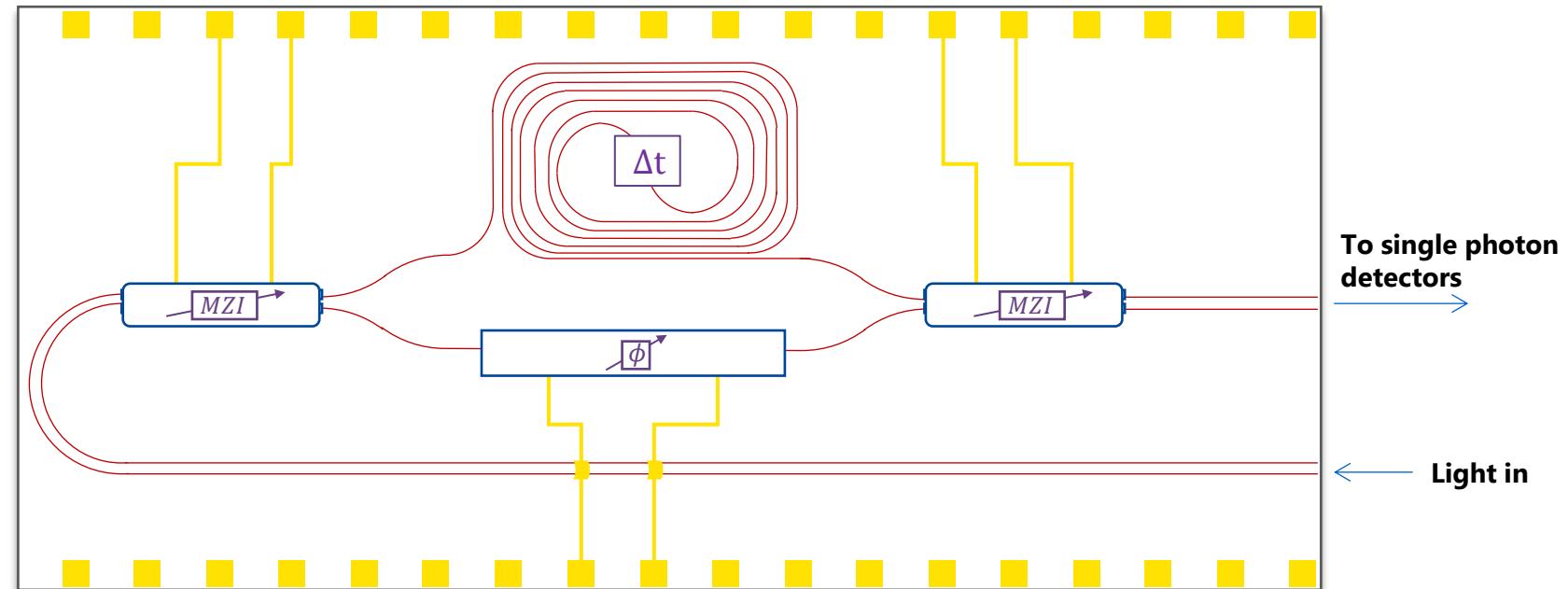
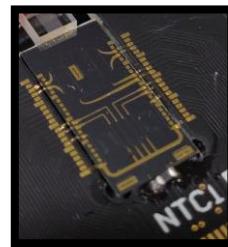
Passive: SiN/SiO₂

Decoding:
Delay-line MZI

Propagation losses:
~0.5 dB/cm

AMZI FSR: 2 GHz

Circuit footprint
4 mm x 8 mm



Insertion losses at receiver → penalty in QKD reach

Main contribution: on-chip delay line

- Propagation losses
- Bending losses

Material	SiO ₂ / Si ₃ N ₄	GaAs	InP	Silica
Group index	1.71	3.29	3.49	1.55
Refr. Ind. contrast [%]	15	25	25	<5
Bending radius [mm]	0.5	0.2	0.25	10
Propagation loss [db/cm]	<0.5	<5	<4	< 0.05
Transparency	VIS/NIR	VIS	NIR	VIS/NIR

Photonic ICs for QKD: Quantum Receiver

QRx CHIP

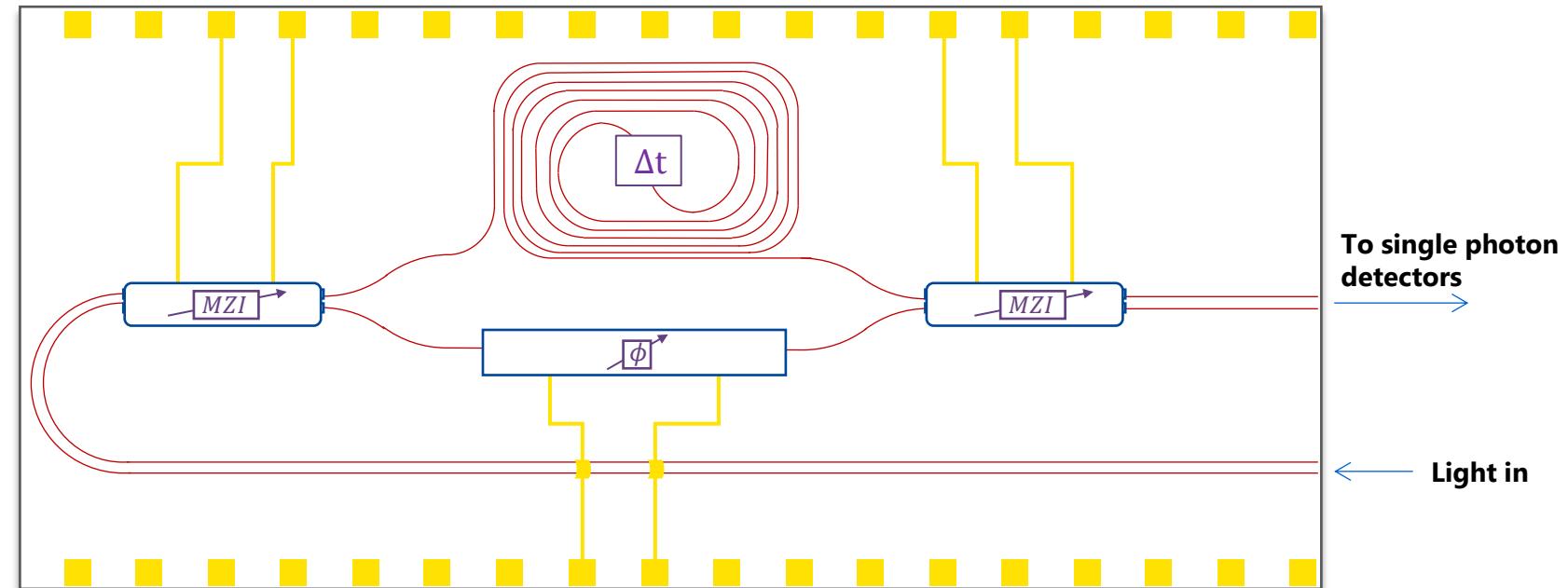
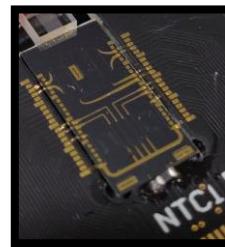
Passive: SiN/SiO₂

Decoding:
Delay-line MZI

Propagation losses:
~0.5 dB/cm

AMZI FSR: 2 GHz

Circuit footprint
4 mm x 8 mm



Insertion losses at receiver → penalty in QKD reach

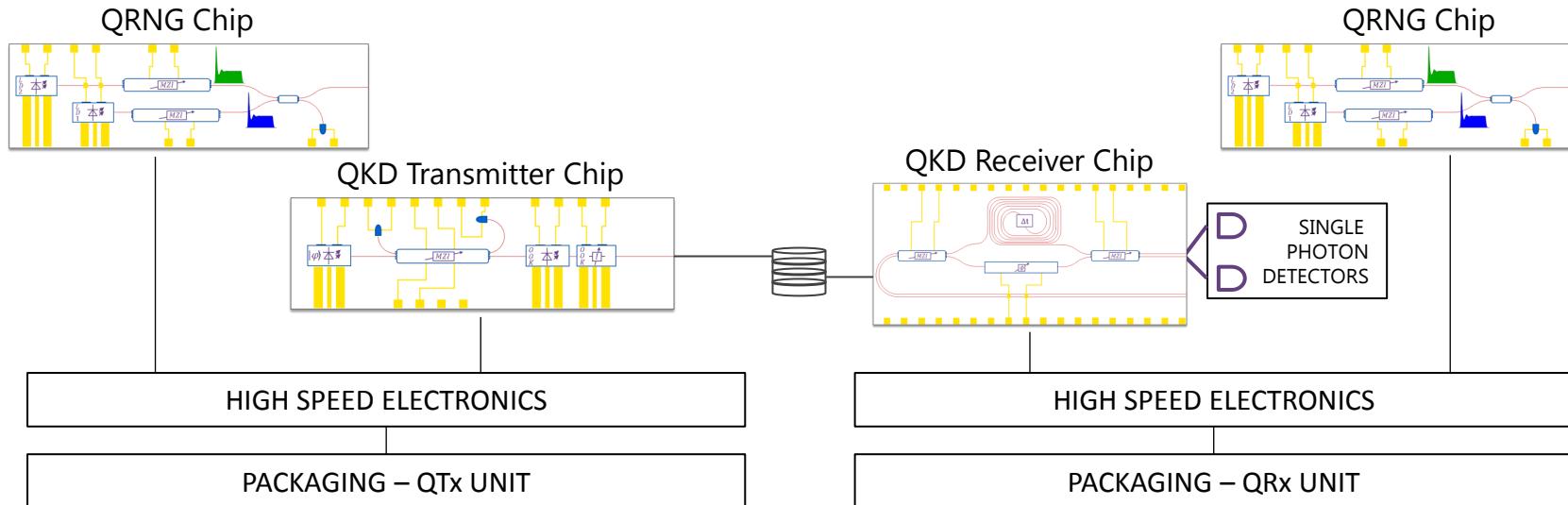
Main contribution: on-chip delay line

- Propagation losses
- Bending losses

Loss vs footprint trade-off

Material	SiO ₂ / Si ₃ N ₄	GaAs	InP	Silica
Total loss (dB)	4.5	22.80	17.19	0.48
Delay line footprint (approx.)	<5 mm ²	~1 mm ²	~1 mm ²	~ cm ²

System integration challenges



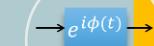
- Global phase randomization
- Bit, basis choices
- Optimally biased choices
- High bit rate QRNG

Quantum random numbers generator



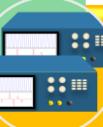
- Large number of RF channels
- Increased footprint
- High V_{π} -x-> CMOS level compatibility
- Complex electronics

Phase modulation technique
Si: CDM, InP: EOPM



- Compact RF drive & processing electronics**
- Power consumption
- Thermal management**
- Co-design optical chips and control electronics

Remove lab equipment for driving/processing



- Photonic packaging**
- Optoelectronic assembly
- Clock distribution and synchronization
- Stability – feedback control**
- Long term operation

System integration



- Real-time random choice variables**
- Real time public communication
- Error-correction, Privacy amplification
- Data-encryption**

Real-time operation



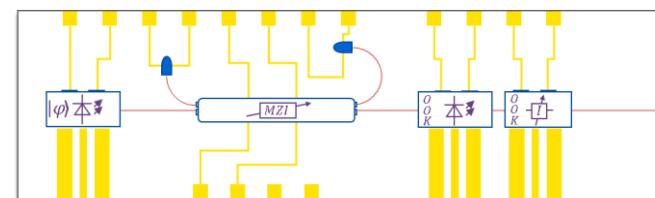
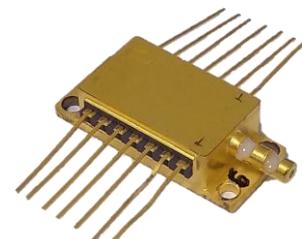
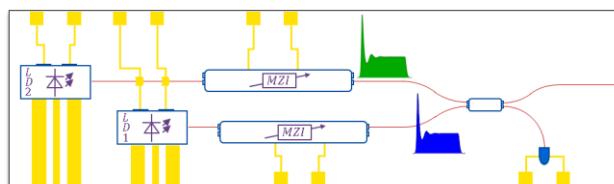
quantum secure

power efficient

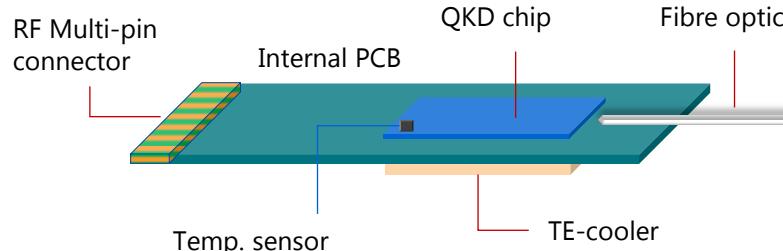
deployable units

Photonic Packaging

- Interface QKD chip and driving electronics
 - Optical interface with outside world
 - Thermal control and management ($dT < 0.005^\circ\text{C}$)
 - Provide protection for photonic circuit
-
- QRNG package
 - 14-pin butterfly
 - Compatibility with pre-existing electronics

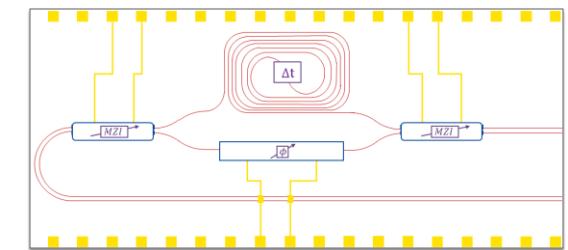
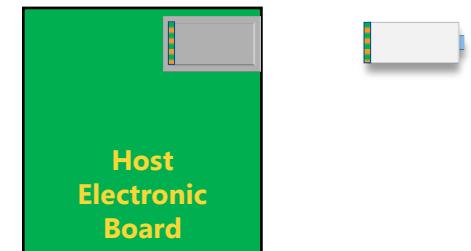


QKD
Transmitter
module (QTx)



- QTx, QRx package

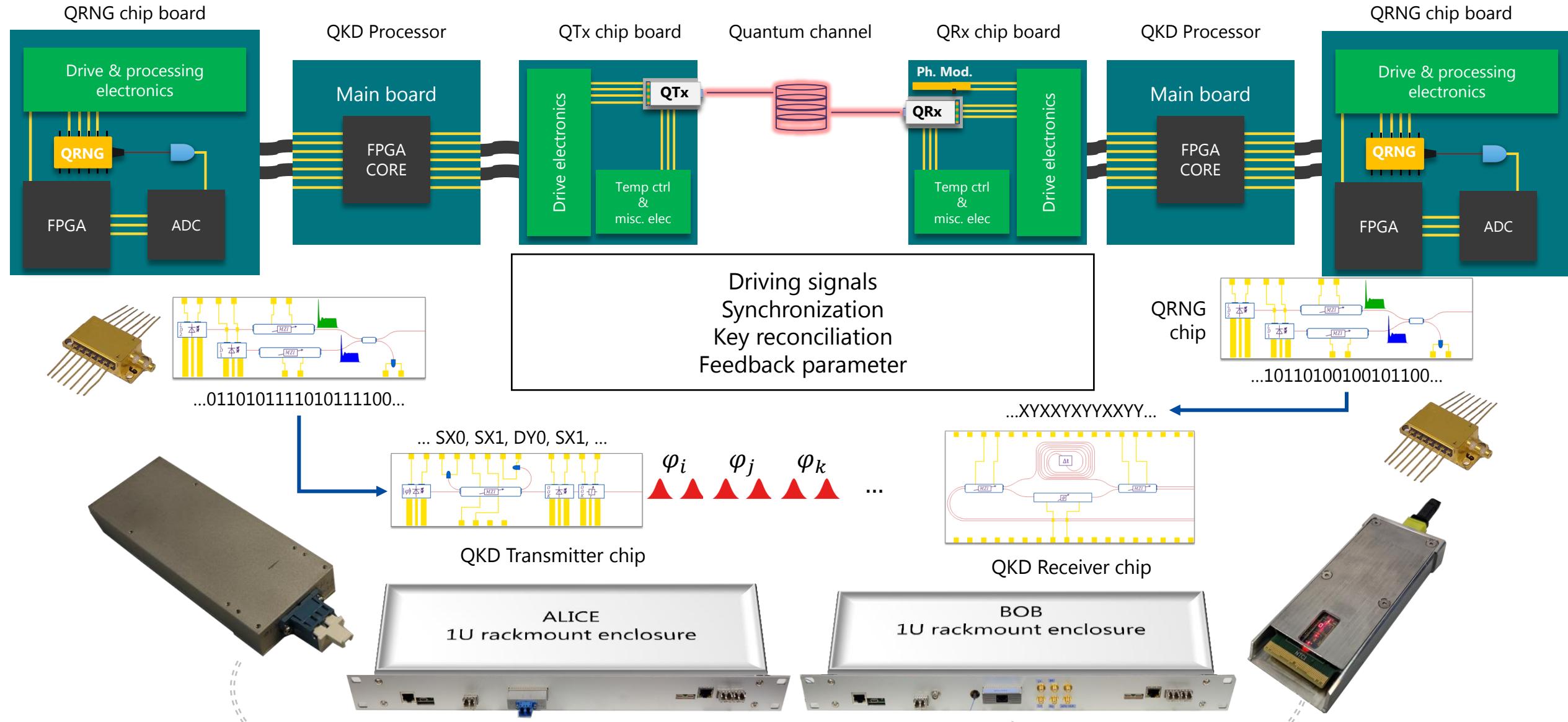
- Pluggable compact form factor modules (CFP2)
- Same approach as coherent optical comms.
- Off-the shelf parts
- Optics upgrade



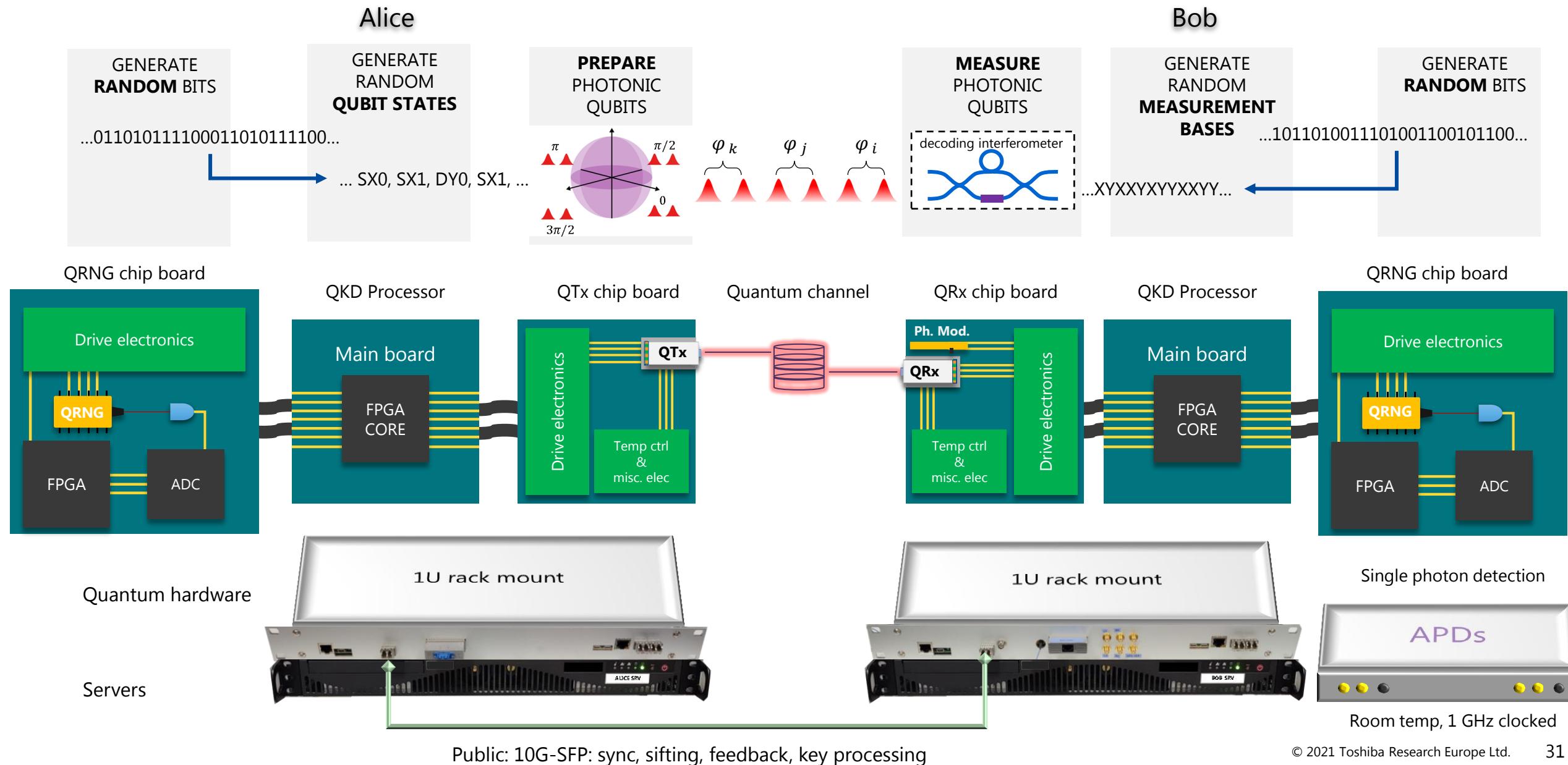
QKD
Receiver
module (QRx)
Plugged in cage,
with heat sink



Real-time, High-speed Control Electronics



Real-time, High-speed Control Electronics



Stability and performance over long fibres

Fibre spools– metro distances

T12 Protocol:

- $P(\text{Basis} = X) = 15/16$
- $P(\text{Decoy}) = P(\text{Vacuum}) = 1/16$

Long term stability:

- >12h no interruption, no user intervention
- 0 dB sift rate: 4.6 Mb/s, QBER < 3.8%

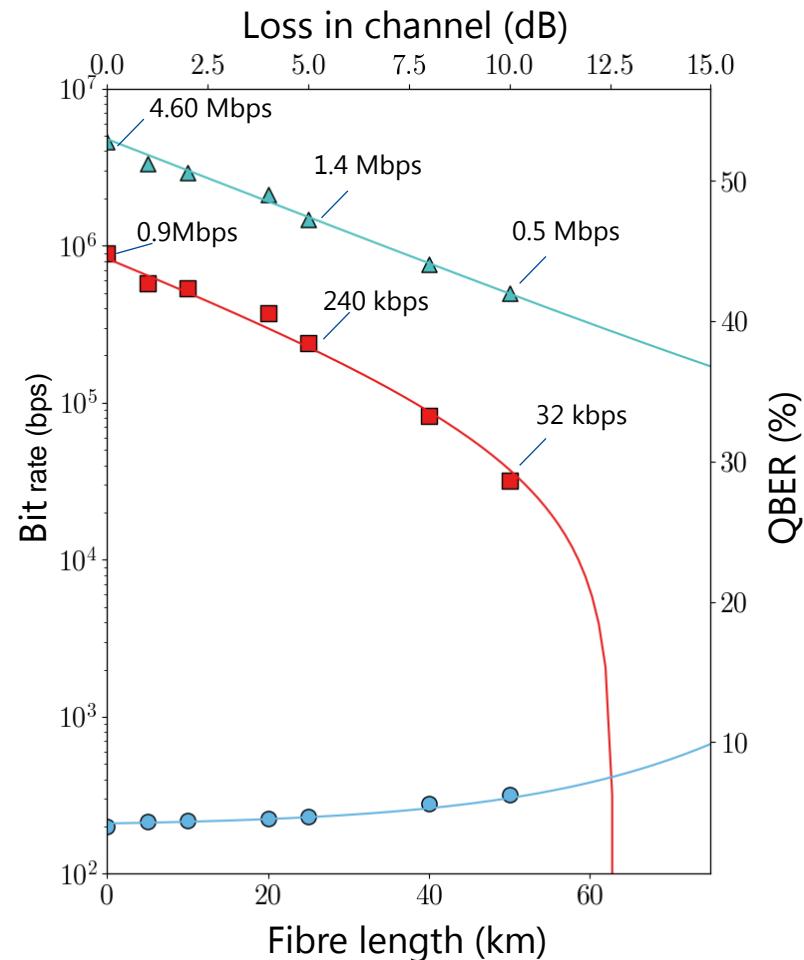
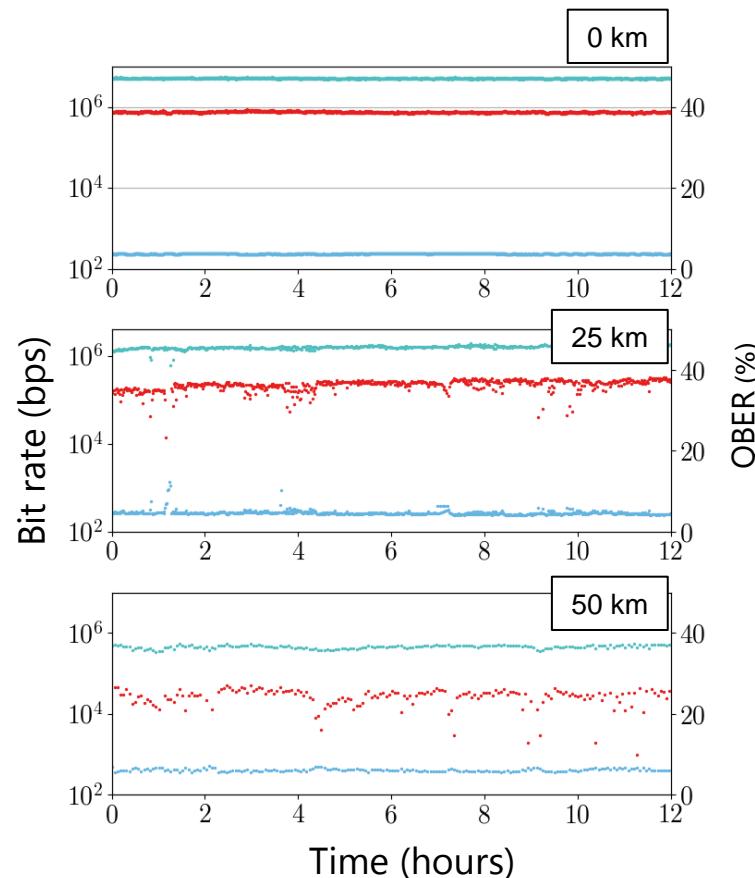
Feedback:

Phase drift compensation

Timing compensation in long fibres

Total receiver loss: ~8 dB

- QRx chip IL: 4.5 dB
- APD efficiency: 10%



deployable units

T. K. Paraíso, T. Roger, D. G. Marangon, I. De Marco, M. Sanzaro, R. I. Woodward, J. F. Dynes, Z. Yuan and A. J. Shields,
"A Photonic Integrated Quantum Communication System," Nature Photonics (2021).

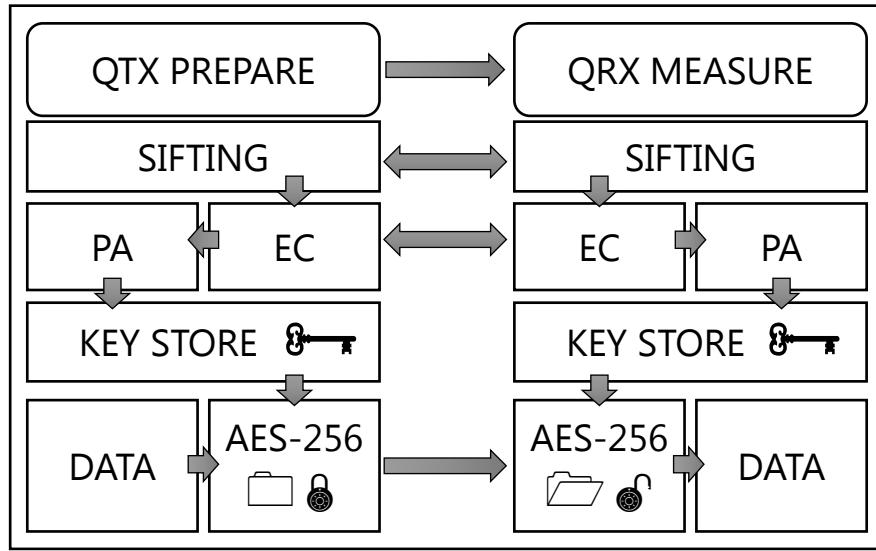
Fully Deployable Autonomous System

Real conditions

100G data encryption rate

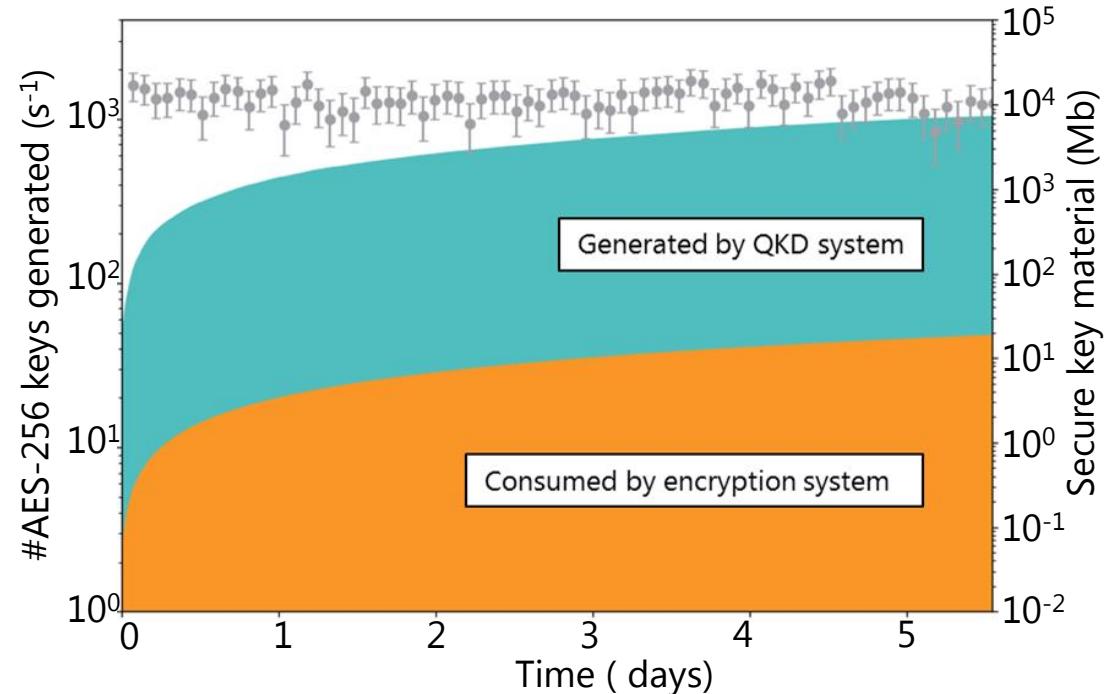
AES 256 (256+96 init.) bits

Key management API compliant
with ETSI GS QKD 014 standard

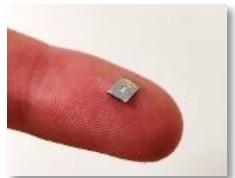


deployable units

Channel loss	10 km
Secure key rate (SKR)	470 kbps
Standard deviation SKR	110 kbps
QBER	4.50 %
Sift rate	3.1 Mbps
QKD key block size	98.5 Mb
AES key size	256 + 96 bits (init.)
Number of AES keys per second	1335



From Single Chips to Standalone System: a timeline

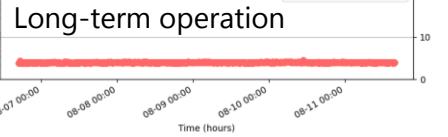


Single Photonic Chips

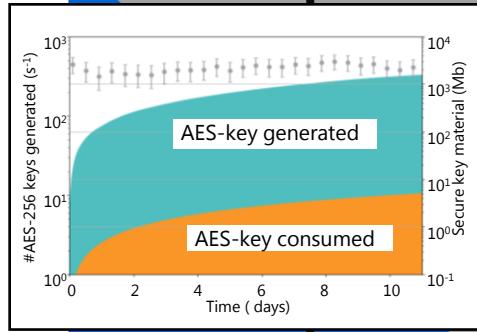
Individual chips

QKD Transmitter
Pluggable module
QRNG module

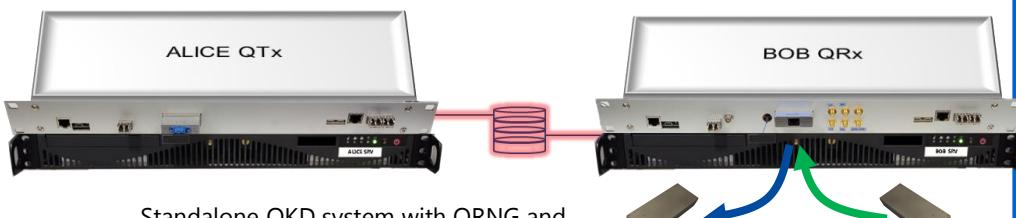
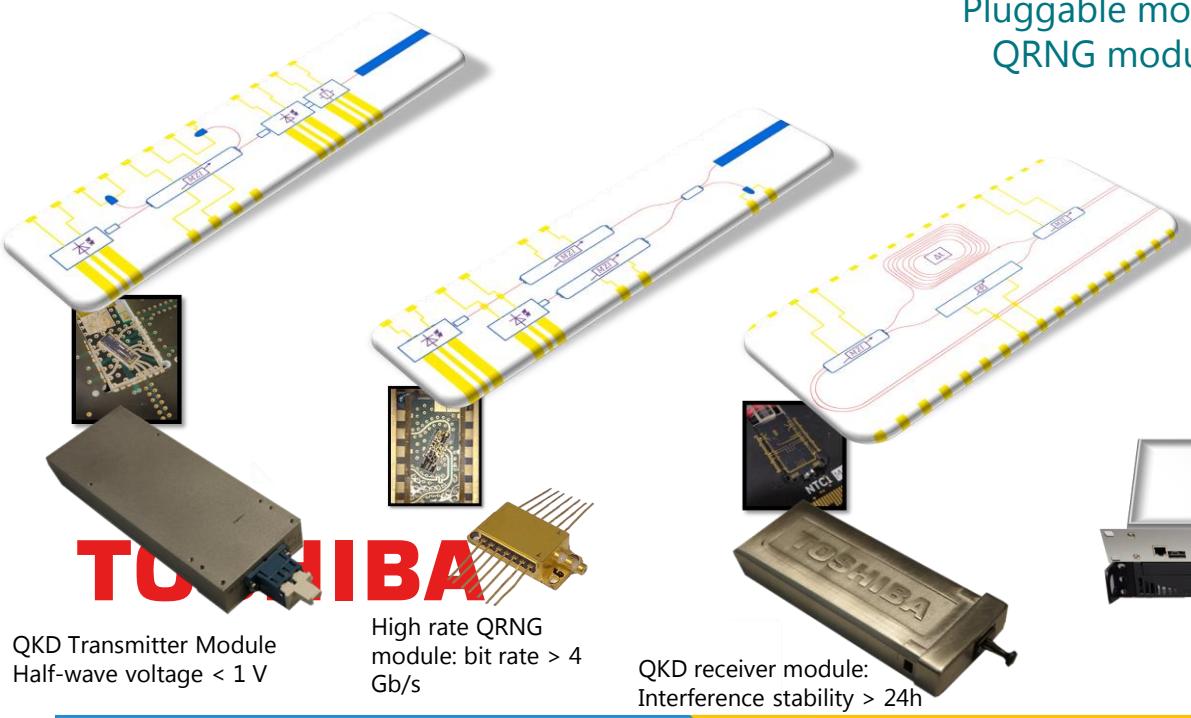
QKD Receiver
Pluggable module



Photonic integrated
QKD system



Interface with
100 G encryptors
via standard KMS

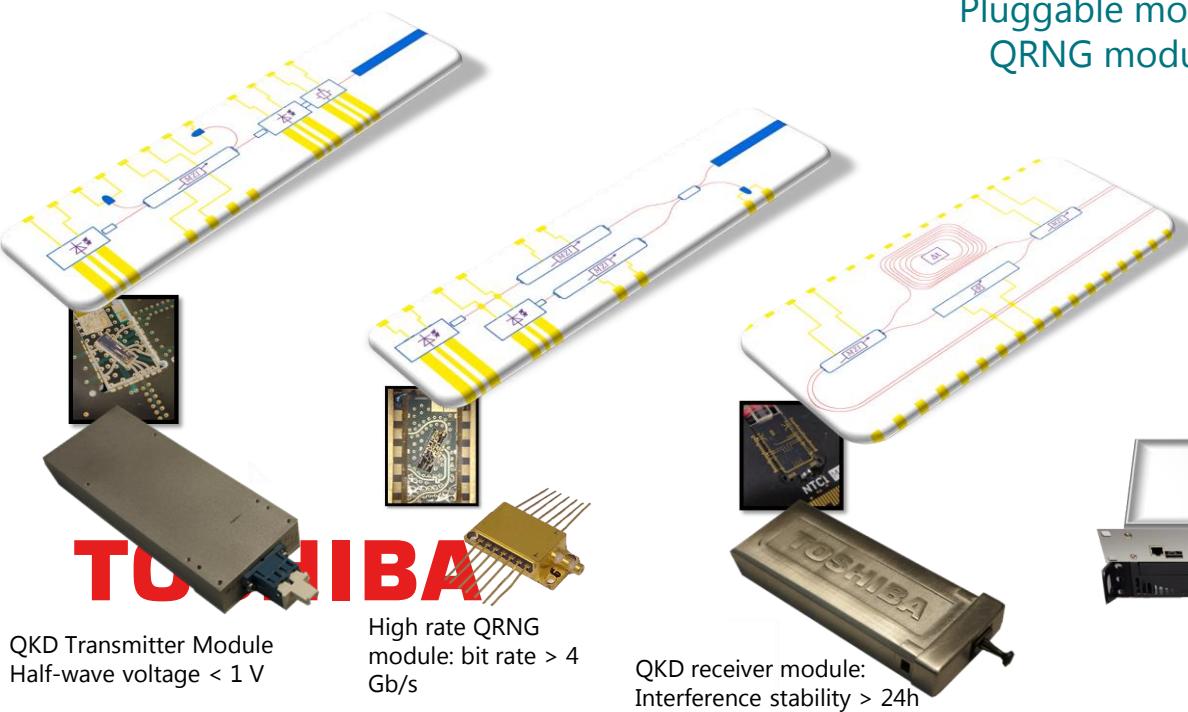
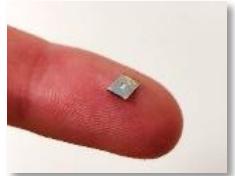


Standalone QKD system with QRNG and QKD modules SKR ~ 1Mb/s

quantum secure

power efficient

deployable units



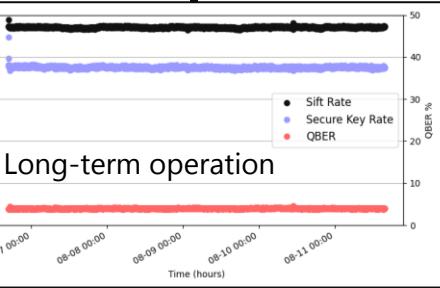
From Single Chips to Standalone System: a timeline

Thank you for your attention. Questions?

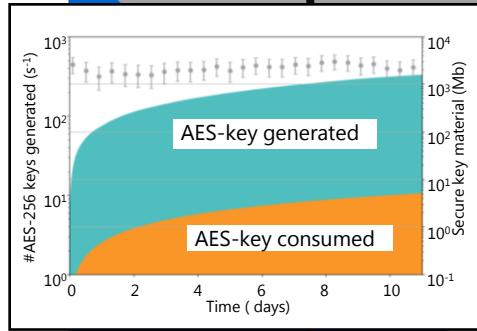
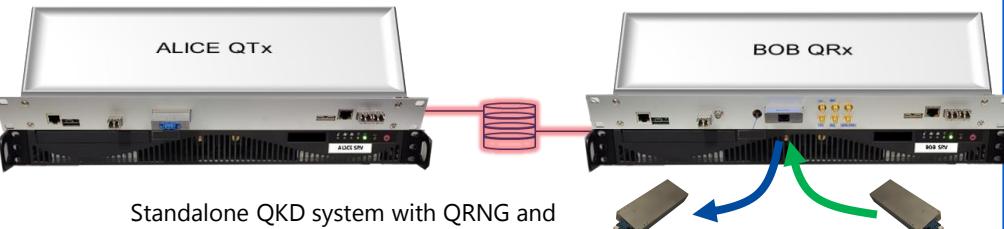
Individual chips

QKD Transmitter
Pluggable module
QRNG module

QKD Receiver
Pluggable module



Photonic integrated
QKD system



Interface with
100 G encryptors
via standard KMS

quantum secure

power efficient

deployable units